



**SGI® Rackable™ C2108-TY10 System
User's Guide**

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Record of Revision

Version	Description
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Contents

	Record of Revision	iii
	About This Guidexvii
1	Introduction	1
	Server Board Features	3
	Processors	3
	Memory	3
	Serial ATA	3
	PCI Expansion Slots	3
	UIO	3
	Onboard Controllers/Ports	4
	ATI Graphics Controller	4
	Other Features	4
	Server Chassis Features	4
	System Power	4
	Serial ATA Subsystem	5
	Front Control Panel	5
	Motherboard	5
	Cooling System	5
2	Server Installation	7
	Unpack the System	7
	Prepare for Setup	7
	Choose a Setup Location	7
	Warnings and Precautions	8
	Rack Precautions	8
	Server Precautions	9
	Rack Mounting Considerations	9

Ambient Operating Temperature	9
Reduced Airflow	9
Mechanical Loading	9
Circuit Overloading	10
Reliable Ground	10
Install the System into a Rack	10
Separate the Sections of the Rack Rails	10
Outer Rack Rails.	12
Install the Outer Rails to the Rack	12
Install the Inner Rail Extension	12
Install the Inner Rails	12
Install the Server in a Rack	13
Check the Node Board Setup.	14
Access the Inside of the Chassis.	14
Check the CPUs (processors)	16
Check the System Memory	16
Install Expansion PCI Cards.	16
Check all Cable Connections and Airflow	16
Check the Drive Bay Setup	16
Check the System Disk Drives	16
Check the Airflow	17
Supply Power to the System	17
3 System Interface.	19
Overview	19
Control Panel Buttons	19
Control Panel LEDs	20
Power Fail	20
Overheat/Fan Fail	20
NIC1	21
NIC2	21
HDD	21
Power	22
SATA Drive Carrier LEDs	22

4	System Safety	23
	Electrical Safety Precautions	23
	General Safety Precautions	24
	ESD Precautions	25
5	Advanced Serverboard Setup	27
	Handling the Node Board	27
	ESD Precautions	28
	Unpacking	28
	Connecting the Control Panel	28
	I/O Ports	29
	Serverboard Details	30
	Serverboard Quick Reference	32
	Installing Memory	32
	Install DIMMs	32
	Memory Configuration	35
	Memory DIMM Layout	36
	Memory DIMM Rules	37
	Mixing Processors and DIMM Speeds	39
	Hard Disk Drives (SGI Rackable C2108-TY10 Chassis)	45
	PCI Card Slotting	46
	Installing Selected PCI cards	47
	Power Supply	48
6	Advanced Chassis Setup	49
	Static-Sensitive Device	51
	Precautions	51
	Unpacking	51
	Control Panel	51
	System Fans	52
	System Fan Failure	52
	Replacing System Fans	53
	Removing a Fan	53
	Installing a New Fan	53

Drive Bay Installation/Removal	53
Accessing the Drive Bays	53
SATA Drive Installation.	54
Mounting a SATA Drive in a Drive Carrier	54
Installing/Removing Hot-swap SATA Drives	54
Hard Drive Backplane	56
DVD-ROM Drive Installation	56
Accessing the Inside of the Chassis	56
Power Supply.	56
Power Supply Failure	56
Removing/Replacing the Power Supply.	57
Removing the Power Supply	57
Installing a New Power Supply.	57
7 BIOS	59
Starting BIOS Setup Utility	59
How To Change the Configuration Data.	60
Starting the Setup Utility.	60
Main Setup	60
System Time/System Update	61
Serverboard	61
Processor.	62
System Memory	62
Advanced Setup Configurations	62
Boot Features	63
Quick Boot	63
Quiet Boot	64
AddOn ROM Display Mode	64
Bootup Num-Lock	64
Wait For 'F1' If Error	64
Hit 'Del' Message Display	64
Interrupt 19 Capture	64
Power Configuration	64
Power Button Function	65

Restore on AC Power Loss	65
Watch Dog Timer	65
Processor and Clock Options	65
Ratio CMOS Setting	65
C1E Support	65
Hardware Prefetcher (Available when supported by the CPU)	66
Adjacent Cache Line Prefetch (Available when supported by the CPU)	66
Intel Virtualization Technology (Available when supported by the CPU)	66
Execute-Disable Bit Capability (Available when supported by the OS and the CPU)	66
Simultaneous Multi-Threading (Available when supported by the CPU).	66
Active Processor Cores	66
Intel EIST Technology.	67
Intel TurboMode Technology (Available when Intel EIST Technology is enabled)	67
Intel C-STATE Tech	67
C-State package limit setting (Available when Intel® C-State Tech is enabled)	67
C1 Auto Demotion.	67
C3 Auto Demotion.	67
Clock Spread Spectrum	67
Advanced Chipset Control	68
CPU Bridge Configuration.	68
Serial Debug Message Level	70
North Bridge Configuration	70
Crystal Beach/Direct Memory Access (DMA)	70
Crystal Beach/ Direct Cache Access (DCA)	71
Intel VT-d	71
SouthBridge Configuration.	71
USB Functions.	71
Legacy USB Support	71
USB 2.0 Controller	71
USB 2.0 Controller Mode	72
BIOS EHCI Hand-Off	72
Intel PCI-X Hub Configuration.	72
PCI Bus A0/B0 Frequency.	72

I/O Port Decode 72
RAS Sticky Error Handling. 72
VGA 16-Bit Decode 72
IDE and SATA Configuration 73
SATA#1 Configuration. 73
Primary IDE Settings 73
Hot Plug. 76
IDE Detect Timeout (sec) 76
PCI/PnP Configuration 76
Clear NVRAM 76
Plug & Play OS 76
PCI Latency Timer 77
PCI IDE BusMaster. 77
Load Onboard LAN1 Option ROM/Load Onboard LAN2 Option ROM 77
Super IO Device Configuration 77
Serial Port1 Address/ Serial Port2 Address. 77
Remote Access Configuration 77
Remote Access 77
Hardware Health Monitor 79
CPU Overheat Alarm 79
CPU Temperature/System Temperature 79
ACPI Configuration 81
ACPI Version Features 81
ACPI APIC Support 81
APIC ACPI SCI IRQ 82
Headless Mode 82
High Performance Event Timer 82
Trusted Computing 82
TCG/TPM Support 82
IPMI Configuration 83
Status of BMC 83
View BMC System Event Log 83
Clear BMC System Event Log 83

Set LAN Configuration	84
IP Address Configuration	84
Parameter Selector	84
IP Address	84
Current IP Address in BMC	84
MAC Address Configuration	85
Parameter Selector	85
Mac Address	85
Current Mac Address in BMC	85
Subnet Mask Configuration	85
Parameter Selector	85
Subnet Mask	85
SEL PEF Configuration	86
PEF Support	86
PEF Action Global Control	86
Alert Startup Delay	86
PEF Alert Startup Delay	86
Startup Delay	86
PEF Startup Delay	87
BMC Watch Dog Timer Action	87
DMI Event Log	87
View Event Log	87
Mark all events as read.	88
Clear event log	88
Security Settings.	88
Boot Configuration	89
Boot Device Priority	90
Hard Disk Drives	91
Removable Drives	91
Exit Options	91
Save Changes and Exit	92
Discard Changes and Exit	92
Discard Changes	93

	Load Optimal Defaults 93
	Load Fail-Safe Defaults 93
A	BIOS Error Codes 95
B	System Specifications 97
	Processors 97
	Chipset 97
	BIOS 97
	Memory Capacity 97
	SATA Controller 97
	SATA Drive Bays 98
	Peripheral Drive Bays 98
	Expansion Slots 98
	Serverboard 98
	Chassis 98
	Weight 98
	System Cooling 99
	System Input Requirements 99
	Power Supply. 99
	Operating Environment 99
	Regulatory Compliance	100

Figures

Figure 1-1	SGI Rackable C2108-TY10 Server	1
Figure 1-2	Intel 5520/ICH10R Chipset System Block Diagram.	6
Figure 2-1	Separating and Installing the Rack Rails.	11
Figure 2-2	Installing the Server in a Rack	13
Figure 2-3	Accessing the Inside of the System	15
Figure 3-1	System Reset Button	19
Figure 3-2	System Power On Button	20
Figure 3-3	Power Fail LED	20
Figure 3-4	Overheat/Fan Fail LED	21
Figure 3-5	LAN1 Network Activity NIC1 LED	21
Figure 3-6	LAN2 Network Activity NIC2 LED	21
Figure 3-7	Hard Drive Activity LED	22
Figure 3-8	Power On LED	22
Figure 4-1	Installing the Onboard Battery	24
Figure 5-1	Control Panel Header Pins	29
Figure 5-2	I/O Ports Locations	29
Figure 5-3	Node Board Features	31
Figure 5-4	DIMM Installation	33
Figure 5-5	Installing DIMM Modules	34
Figure 5-6	Removing a DIMM Module	35
Figure 5-7	Memory DIMM Locations	36
Figure 5-8	Memory Block Diagram	37
Figure 5-9	SGI Rackable C2108-TY10 Disk Drive Locations	45
Figure 5-10	Base PCI card configuration	47
Figure 6-1	Front and Rear Chassis Views	50
Figure 6-2	Removing System Cooling Fans	52
Figure 6-3	Mounting a SATA Drive in a Carrier	54
Figure 6-4	Removing SATA Drive Carrier	55

Figure 7-1	System Overview Main BIOS Setup Screen 61
Figure 7-2	Advanced Settings Screen 63
Figure 7-3	Security Settings Screen 88
Figure 7-4	Boot Settings Screen 90
Figure 7-5	Exit Options Screen 92

Tables

Table 5-1	Jumper Descripton	32
Table 5-2	Recommended Memory DIMM Configurations	40
Table 5-3	Non-Optimal Memory DIMM Configurations	43
Table A-1	BIOS Error Codes	95

About This Guide

This guide provides an overview of the installation, architecture, general operation, and descriptions of the major components in the SGI® Rackable® C2108-TY10 server. It also provides basic troubleshooting and maintenance information, BIOS information, and important safety and regulatory specifications.

Audience

This guide is written for owners, installers, system administrators, and users of SGI Rackable C2108-TY10 computer systems. It is written with the assumption that the reader has a good working knowledge of computers and computer systems.

Chapter Descriptions

The following topics are covered in this guide:

- Chapter 1, “Introduction”
Provides an overview SGI Rackable C2108-TY10 server components.
- Chapter 2, “Server Installation”
Provides a quick setup checklist to get the SGI Rackable C2108-TY10 operational.
- Chapter 3, “System Interface”
Describes several LEDs on the control panel as well as others on the SATA drive carriers that keep you constantly informed of the overall status of the system as well as the activity and health of specific components.
- Chapter 4, “System Safety”
Provides system safety information.
- Chapter 5, “Advanced Severboard Setup”
Provides procedures to install a node board into the SGI Rackable C2108-TY10 chassis, connect the data and power cables, and install expansion cards.

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- Chapter 6, “Advanced Chassis Setup”
Describes the steps required to install components and perform maintenance on the SGI Rackable C2108-TY10 chassis.
 - Chapter 7, “BIOS”
Describes the AMI BIOS Setup Utility for the SGI Rackable C2108-TY10 severboard.
 - [Appendix A, “BIOS Error Codes,”](#)
Provides BIOS error code information.
 - [Appendix B, “System Specifications,”](#)
Describes system component specifications.

Related Publications

The following SGI and LSI documents are relevant to the SGI Rackable C2108-TY10 server:

- *MegaRAID SAS Software User's Guide*, publication number, publication number 860-0488-00x
- *MegaRAID 1078-based SAS RAID Controllers User's Guide*, publication number 860-0489-00x
- *LSI Integrated SAS for RAID User's Guide*, publication number 860-0476-00x
- *SGI ProPack 6 for Linux Start Here*, publication number 007-5482-00x
- *SGI InfiniteStorage* series documentation
- Man pages (online)

You can obtain SGI documentation (as well as the pertinent LSI books), release notes, or man pages in the following ways:

- Refer to the SGI Technical Publications Library at <http://docs.sgi.com>. Various formats are available. This library contains the most recent and most comprehensive set of online books, release notes, man pages, and other information.
- You can also view man pages by typing **man <title>** on a command line.

SGI systems include a set of Linux® man pages, formatted in the standard UNIX® “man page” style. Important system configuration files and commands are documented on man pages. These are found online on the internal system disk (or DVD-CD) and are displayed using the **man** command. For example, to display the man page for the **xscsidisktest** command, type the following on a command line:

```
man xscsidisktest
```

For additional information about displaying man pages using the **man** command, see **man(1)**.

In addition, the **apropos** command locates man pages based on keywords. For example, to display a list of man pages that describe disks, type the following on a command line:

```
apropos disk
```

For information about setting up and using **apropos**, see **apropos(1)**.

Conventions

The following conventions are used throughout this document:

Convention	Meaning
Command	This fixed-space font denotes literal items such as commands, files, routines, path names, signals, messages, and programming language structures.
<i>variable</i>	The italic typeface denotes variable entries and words or concepts being defined. Italic typeface is also used for book titles.
user input	This bold fixed-space font denotes literal items that the user enters in interactive sessions. Output is shown in nonbold, fixed-space font.
[]	Brackets enclose optional portions of a command or directive line.
...	Ellipses indicate that a preceding element can be repeated.
man page(x)	Man page section identifiers appear in parentheses after man page names.
GUI element	This font denotes the names of graphical user interface (GUI) elements such as windows, screens, dialog boxes, menus, toolbars, icons, buttons, boxes, fields, and lists.

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Introduction

Important: SGI Rackable systems may sometimes require driver versions that are not included in the original operating system release. SGI provides these required drivers on the SGI Rackable Driver CD, which ships with all SGI Rackable systems, and on systems that are pre-installed in the factory. For more information, check with your sales or service representative.

The SGI Rackable C2108-TY10 server is a 2U rackmount server (see [Figure 1-1](#)). It has two main subsystems: the 2U server chassis and the dual processor serverboard.

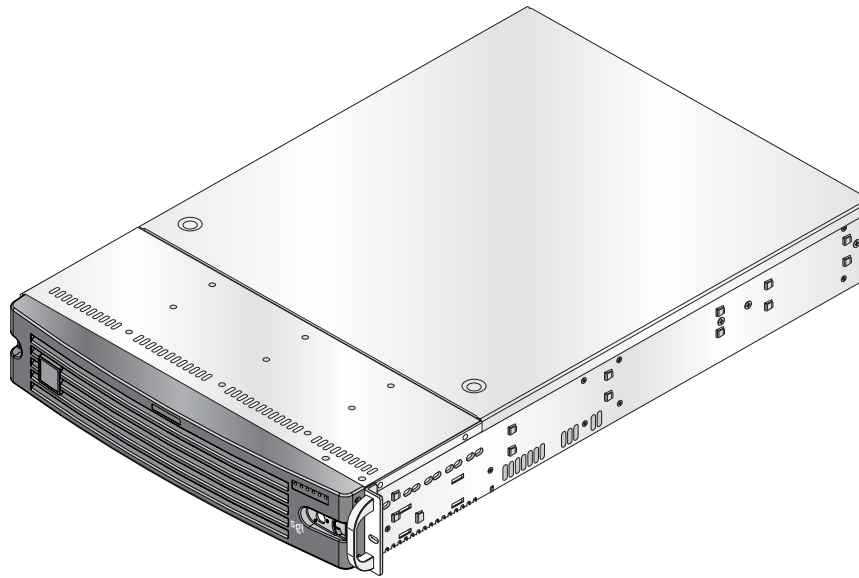


Figure 1-1 SGI Rackable C2108-TY10 Server

In addition to the serverboard and chassis, various hardware components have been included with the SGI Rackable C2108-TY10, as listed below:

- One slim DVD-ROM drive (optional)
- Three 8-cm chassis fans

- Two passive heatsinks
- One air shroud
- SATA and SAS Accessories
 - One SAS/SATA backplane
 - One 2-ft. SATA cable
 - Two 35-cm SATA cables
 - Two 40-cm SGPIO cables
 - Two 48-cm SATA cables
 - One 70-cm SATA cable
 - Eight drive carriers
- One rackmount kit
- One CD containing drivers and utilities

Server Board Features

At the heart of the SGI Rackable C2108-TY10 system is a dual processor serverboard based on the Intel 5520 + ICH10R chipset and designed to provide maximum performance. Below are the main features of the serverboard.

Processors

The serverboard supports single or dual Intel® Xeon® 5500 processors. The Intel® Xeon® 5200 and 5400 processors are not supported.

Memory

The serverboard has eighteen DIMM slots that can support up to 144 GB of DDR3 1333/1066/800 registered ECC SDRAM (see [“Installing Memory”](#) on page 32).

Serial ATA

A Serial ATA controller is integrated into the ICH10R (South Bridge) portion of the chipset to provide a six-port 3 Gb/s SATA subsystem, which is RAID 0, 1, 10 and 5 supported. The SATA drives are hot-swappable units.

Note: The SATA drives are hot-swappable units if your operating systems has RAID support.

PCI Expansion Slots

The dual processor serverboard has two low-profile PCI Express 2.0 x8 slots, one low-profile PCI Express x4 slot (in a x8 slot), three low-profile 64-bit 133/100 MHz PCI-X slots and one UIO slot (see [“PCI Card Slotting”](#) on page 46)

UIO

The serverboard is a specially-designed serverboard that features Universal I/O (UIO) technology. UIO serverboards have a PCI-Express x8 connector that can support one of two types of UIO card types, L8i and H8iR (low-profile only) to add SAS ports, additional LAN ports, and so on, to the serverboard.

Note: The SGI Rackable C2108-TY10 does not come with a UIO card pre-installed.

When the RAID option is ordered, this slot is filled with the RAID card.

Onboard Controllers/Ports

One onboard ATA/100 connector, which supports IDE hard drives or ATAPI devices. The color-coded I/O ports include one COM port (an additional COM header is located on the serverboard), a VGA (monitor) port, two USB 2.0 ports (two additional USB headers and one Type A port are included on the serverboard), PS/2 mouse and keyboard ports and two gigabit Ethernet ports.

ATI Graphics Controller

The dual processor serverboard features an integrated ATI video controller based on the ES1000 32 MB graphics chip. The ES1000 was designed specifically for servers, featuring low power consumption, high reliability and superior longevity.

Other Features

Other onboard features that promote system health include onboard voltage monitors, a chassis intrusion header, auto-switching voltage regulators, chassis and CPU overheat sensors, virus protection and BIOS rescue.

Server Chassis Features

The following is a general outline of the main features of the SGI Rackable C2108-TY10 server chassis.

System Power

The SGI Rackable C2108-TY10 server chassis features a redundant 720W power supply composed of two separate power modules. This power redundancy feature allows you to replace a failed power supply without shutting down the system.

Serial ATA Subsystem

The SGI Rackable C2108-TY10 server chassis supports up to six 3 Gb/s Serial ATA drives. The SATA drives are hot-swappable units and are connected to a backplane that provides power and control.

Note: The operating system you have installed must support RAID to enable the hot-swap capability of the SATA drives.

Front Control Panel

The control panel on the SGI Rackable C2108-TY10 provides you with system monitoring and control. LEDs that indicate system power, HDD activity, network activity, system overheat and power supply failure. A main power button and a system reset button are also included. In addition, two USB ports and one serial port have been incorporated into the control panel to provide front side USB and COM port access.

Motherboard

The SGI Rackable C2108-TY10 server chassis is an ATX form factor chassis designed to be used in a 2U rackmount configuration. The motherboard provides one UIO slot, seven low-profile expansion slots, one COM port, a VGA port, two USB 2.0 ports, PS/2 mouse and keyboard ports and two Gigabit Ethernet ports.

Cooling System

The SGI Rackable C2108-TY10 server chassis has an innovative cooling design that includes three 8-cm hot-plug system cooling fans located in the middle section of the chassis. An air shroud channels the airflow from the system fans to efficiently cool the processor area of the system. The power supply module also includes a cooling fan.

Figure 1-2 shows a general block diagram of the Intel 5520/ICH10R chipset.

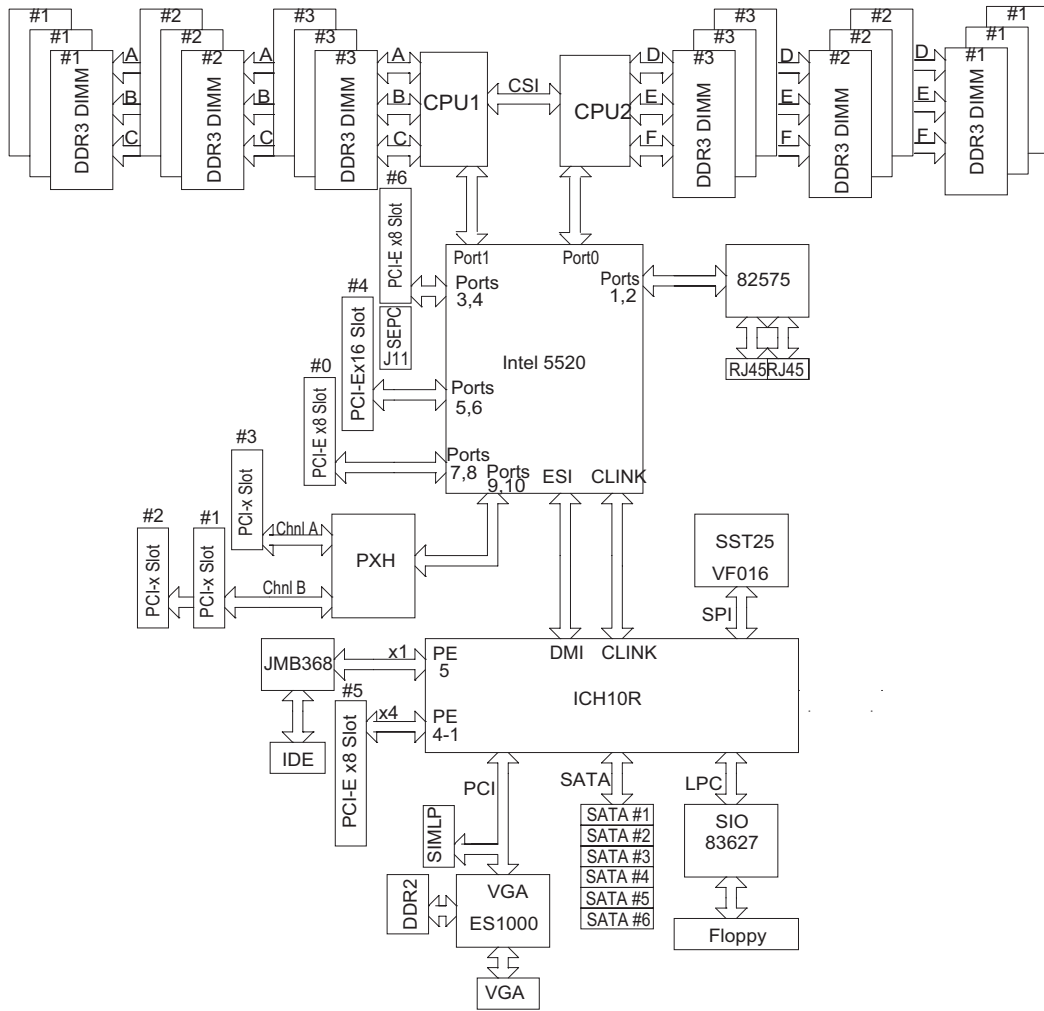


Figure 1-2 Intel 5520/ICH10R Chipset System Block Diagram

Server Installation

This chapter provides a quick setup checklist to get the SGI Rackable C2108-TY10 operational.

Unpack the System

Inspect the shipping container that the SGI Rackable C2108-TY10 was shipped in and note if it was damaged in any way. If the server shows damage, file a damage claim with the carrier who delivered it.

Decide on a suitable location for the rack that supports the weight, power requirements, and environmental requirements of the SGI Rackable C2108-TY10 server. It should be situated in a clean, dust-free environment that is well ventilated. Avoid areas where heat, electrical noise, and electromagnetic fields are generated. Place the server rack near a grounded power outlet. Refer to [“Warnings and Precautions”](#) on page 8.

Prepare for Setup

The shipping container should include two sets of rail assemblies, two rail mounting brackets and the mounting screws that you will use to install the system into a rack.

Read this section in its entirety before you begin the installation procedure.

Choose a Setup Location

Leave enough clearance in front of the rack to enable you to open the front door completely (~25 inches) and approximately 30 inches of clearance in the back of the rack to allow for sufficient airflow and ease in servicing.

Warnings and Precautions

Rack Precautions



Warning: The SGI Rackable C2108-TY10 server weighs 57 lbs (26 kg). Always use proper lifting techniques when you move the server. Always get the assistance of another qualified person when you install the sever in a location above your shoulders. Failure to do so may result in serious personal injury or damage to the equipment.



Warning: Extend the leveling jacks on the bottom of the rack to the floor with the full weight of the rack resting on them. Failure to do so can result in serious injury or death.



Warning: Attach stabilizers to the rack in single rack installations. Failure to do so can result in serious injury or death.



Warning: Couple racks together in multiple rack installations. Failure to do so can result in serious injury or death.



Warning: Be sure the rack is stable before extending a component from the rack. Failure to do so can result in serious injury or death.



Warning: Extend only one component at a time. Extending two or more components simultaneously may cause the rack to tip over and result in serious injury or death.

Server Precautions

- Review the electrical and general safety precautions.
- Determine the placement of each component in the rack before you install the rails.
- Install the heaviest server components in the bottom of the rack first, and then work up.
- Use a regulating uninterruptible power supply (UPS) to protect the server from power surges and voltage spikes and to keep your system operating in case of a power failure.
- Allow the hot-pluggable SAS/SATA drives and power supply modules to cool before touching them.
- Always keep the rack's front door and all panels and components on the servers closed when not servicing to maintain proper cooling.

Rack Mounting Considerations

Ambient Operating Temperature

If installed in a closed or multi-unit rack assembly, the ambient operating temperature of the rack environment may be greater than the ambient temperature of the room. Therefore, consideration should be given to installing the equipment in an environment compatible with the manufacturer's maximum rated ambient temperature (35° C or 95° F).

Reduced Airflow

Equipment should be mounted into a rack so that the amount of airflow required for safe operation is not compromised.

Mechanical Loading

Equipment should be mounted into a rack so that a hazardous condition does not arise due to uneven mechanical loading.

Circuit Overloading

Consideration should be given to the connection of the equipment to the power supply circuitry and the effect that any possible overloading of circuits might have on overcurrent protection and power supply wiring. Appropriate consideration of equipment nameplate ratings should be used when addressing this concern.

Reliable Ground

A reliable ground must be maintained at all times. To ensure this, the rack itself should be grounded. Particular attention should be given to power supply connections other than the direct connections to the branch circuit (for example, the use of power strips, and so on).

Install the System into a Rack

This section provides information on installing the SGI Rackable C2108-TY10 into a rack. If the system has already been mounted into a rack, refer to “[Check the Node Board Setup](#)” on page 14. There are a variety of rack units on the market, which may mean the assembly procedure will differ slightly. You should also refer to the installation instructions that came with the rack unit you are using.

Note: This rail will fit a rack between 26" and 33.5" deep.

Separate the Sections of the Rack Rails

The chassis package includes two rail assemblies in the rack mounting kit. Each assembly consists of two sections: an inner fixed chassis rail that secures directly to the server chassis and an outer fixed rack rail that secures directly to the rack itself.

To separate the inner and outer rails, perform the following steps:

1. Locate the rail assembly in the chassis packaging as shown in [Figure 2-1](#).
2. Extend the rail assembly by pulling it outward.
3. Press the quick-release tab

4. Separate the inner rail from the outer rail assembly.

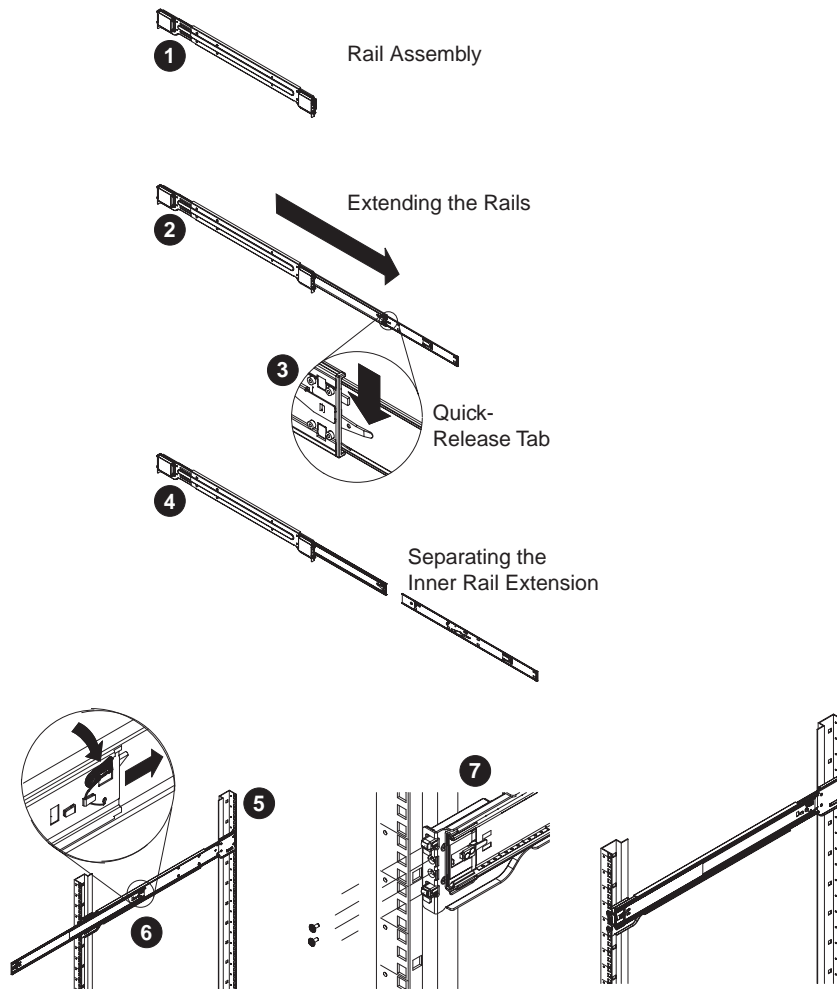


Figure 2-1 Separating and Installing the Rack Rails

Outer Rack Rails

Outer rails attach to the rack and hold the chassis in place. The outer rails for the chassis extend between 30 inches and 33 inches.

Install the Outer Rails to the Rack

5. Secure the back end of the outer rail to the rack, using the screws provided (see [Figure 2-1](#)).
6. Press the button where the two outer rails are joined to retract the smaller outer rail.
7. Hang the hooks of the rails onto the rack holes and if desired, use screws to secure the front of the outer rail onto the rack.
8. Repeat steps 1-3 for the remaining outer rail.

Install the Inner Rail Extension

The SGI Rackable C2108-TY10 chassis includes a set of inner rails in two sections: inner rails and inner rail extensions. The inner rails are pre-attached to the chassis, and do not interfere with normal use of the chassis if you decide not to use a server rack. The inner rail extension is attached to the inner rail to mount the chassis in the rack.

Install the Inner Rails

Perform the following steps to install the inner rails:

1. Place the inner rail extensions on the side of the chassis aligning the hooks of the chassis with the rail extension holes. Make sure the extension faces "outward" just like the pre-attached inner rail.
2. Slide the extension toward the front of the chassis.
3. Secure the chassis with 2 screws as illustrated. Repeat steps for the other inner rail extension.

Install the Server in a Rack



Warning: The SGI Rackable C2108-TY10 server weighs 57 lbs (26 kg) Always use proper lifting techniques when you move the server. Always get the assistance of another qualified person when you install the sever in a location above your shoulders. Failure to do so may result in serious personal injury or damage to the equipment.

You should now have rails attached to both the server chassis and the rack unit. The next step is to install the server into the rack (refer to [Figure 2-2](#)).

1. Extend the outer rails as shown in [Figure 2-2](#).
2. Align the inner rails of the chassis with the outer rails on the rack.
3. Slide the inner rails into the outer rails, keeping the pressure even on both sides. When the chassis has been pushed completely into the rack, it should click into the locked position.
4. Optional screws may be used to secure the to hold the front of the chassis to the rack.

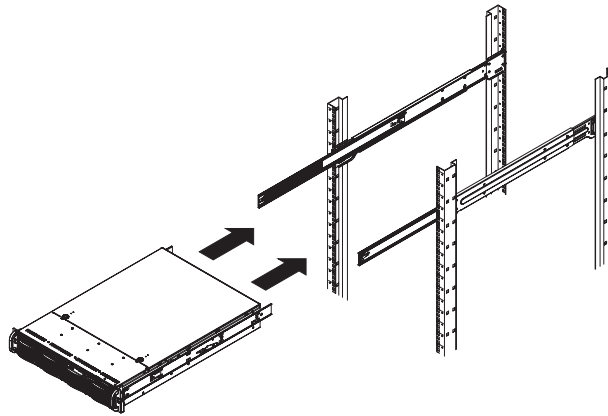


Figure 2-2 Installing the Server in a Rack

Check the Node Board Setup

Use the following sections to open the top cover and check that each node board is properly installed and all the connections have been made.

Access the Inside of the Chassis

1. Grasp the two handles on either side and pull the unit straight out until it locks (you will hear a “click”).
2. Depress the two buttons on the top of the chassis to release the top cover as shown in [Figure 2-3](#).
3. Lift the top cover from the chassis.

Note: To remove the system from the rack completely, depress the locking tabs on the chassis rails (push the right-side tab down and the left-side tab up) to continue to pull the system out past the locked position.

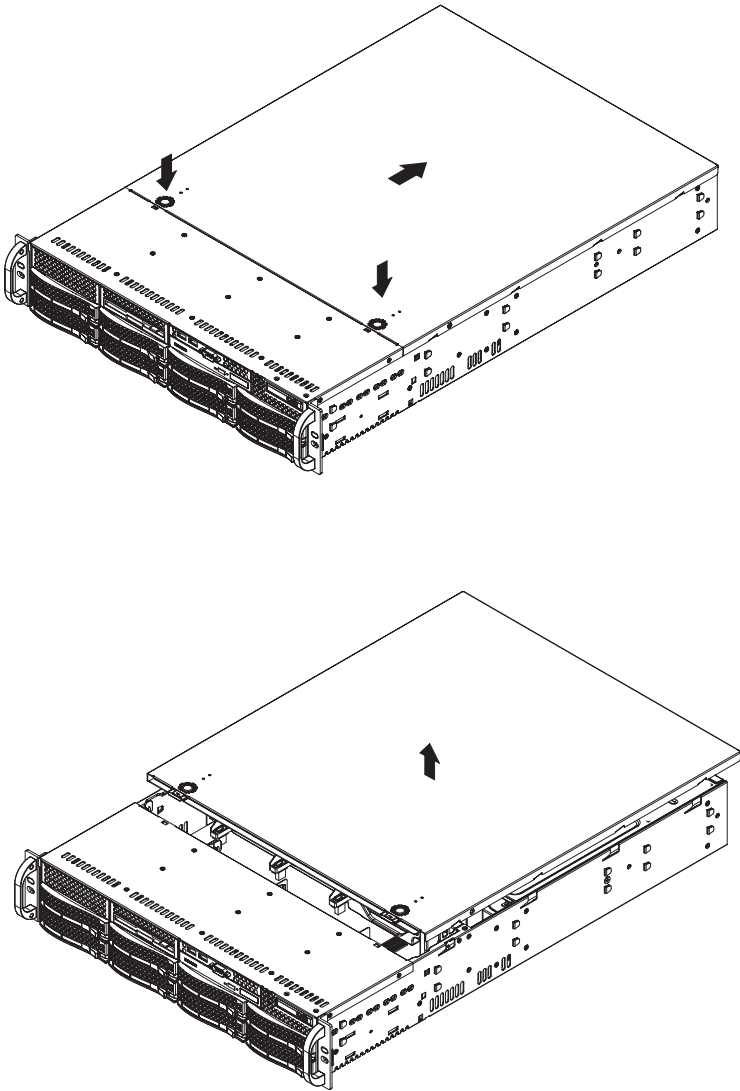


Figure 2-3 Accessing the Inside of the System

Check the CPUs (processors)

You may have one or two processors installed into the serverboard. Each processor needs its own heatsink.

Check the System Memory

Your server system is shipped with system memory installed. Make sure all DIMMs are fully seated in their slots. For details on adding system memory, refer to [Chapter 3](#).

Install Expansion PCI Cards

You can install six expansion PCI cards in the system. Refer to [Chapter 3](#) for details on installing PCI expansion cards.

Check all Cable Connections and Airflow

Make sure all power and data cables are properly connected and not blocking the chassis airflow. Refer to [Chapter 3](#) for details on cable connections.

Check the Drive Bay Setup

Next, you should check to make sure the system disk drives and disk drive backplane have been properly installed and all connections have been made.

Check the System Disk Drives

All drives are accessible from the front of the server. For servicing the DVD-ROM, you will need to remove the top chassis cover. The hard drives can be installed and removed from the front of the chassis without removing the top chassis cover. Depending upon your system configuration, your system may have one or more drives installed. For detailed information about how to install disk drives, see “[Hard Disk Drives \(SGI Rackable C2108-TY10 Chassis\)](#)” on page 45.

If you have more than 4TB of storage, you must create multiple volumes to fully utilize your RAID disks.

Refer to the *MegaRAID SAS Software User's Guide*, SGI publication number 860-0488-00x and the *MegaRAID 1078-based SAS RAID Controllers User's Guide*, SGI publication number 860-0489-00x for more information about configuring your system disks.

A slim DVD-ROM may be preinstalled in your server. Refer to Chapter 6 if you need to install a DVD-ROM disk drive to the system.

Depending upon your system's configuration, your system may have one or more drives already installed. If you need to install hard drives, please refer to Chapter 6.

Check the Airflow

Airflow is provided by three hot-swappable 8-cm chassis cooling fans. The system component layout was carefully designed to direct sufficient cooling airflow to the components that generate the most heat.

Note: Make sure that all power and data cables have been routed in such a way that they do not block the airflow generated by the fans.

Supply Power to the System

If necessary, install the system in a rack (refer to “[Install the System into a Rack](#)” on page 10), and connect the power cord from the power supply module into a power strip or power distribution unit (PDU). SGI also recommends that you use an uninterruptible power supply (UPS) source.

System Interface

Overview

There are several LEDs on the control panel as well as others on the SATA drive carriers to keep you constantly informed of the overall status of the system as well as the activity and health of specific components. There are also two buttons on the chassis control panel.

Control Panel Buttons

There are two buttons located on the front of the chassis: a reset button and a power on/off button. Use the reset button to reboot the system as shown in [Figure 3-1](#).

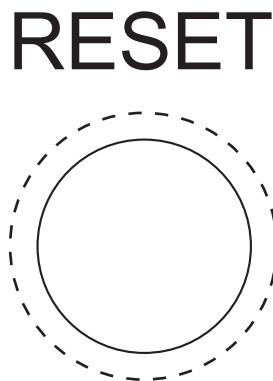


Figure 3-1 System Reset Button

[Figure 3-2](#) shows the the main power button, which is used to apply or turn off the main system power. Turning off system power with this button removes the main power but keeps standby power supplied to the system.

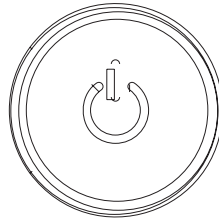


Figure 3-2 System Power On Button

Control Panel LEDs

The control panel located on the front of the chassis has several LEDs. These LEDs provide you with critical information related to different parts of the system. This section explains what each LED indicates when illuminated and any corrective action you may need to take.

Power Fail

The power fail LED indicates a power supply module has failed as shown in [Figure 3-3](#). The second power supply module will take the load and keep the system running but the failed module will need to be replaced. Refer to [Chapter 6](#) for details on replacing the power supply. This LED should be off when the system is operating normally.



Figure 3-3 Power Fail LED

Overheat/Fan Fail

When the red overheat/fan LED flashes (shown in [Figure 3-4](#)), it indicates a fan failure. When on continuously it indicates an overheat condition, which may be caused by cables obstructing the airflow in the system or the ambient room temperature being too warm. Check the routing of

the cables and make sure all fans are present and operating normally. You should also check to make sure that the chassis covers are installed. This LED will remain flashing or on as long as the indicated condition exists.



Figure 3-4 Overheat/Fan Fail LED

NIC1

When flashing, the NIC1 LED indicates network activity on the LAN1 port (see [Figure 3-5](#)).



Figure 3-5 LAN1 Network Activity NIC1 LED

NIC2

When flashing, the NIC2 LED indicates network activity on the LAN2 port (see [Figure 3-6](#)).



Figure 3-6 LAN2 Network Activity NIC2 LED

HDD

The HDD LED indicates hard drive drive activity when flashing (see [Figure 3-7](#)).



Figure 3-7 Hard Drive Activity LED

Power

The power LED indicates power is being supplied to the system's power supply units is shown in [Figure 3-8](#). This LED should normally be illuminated when the system is operating.



Figure 3-8 Power On LED

SATA Drive Carrier LEDs

Each SATA drive carrier has two LEDs, as follows:

- **Green:** When illuminated, the green LED on the SATA drive carrier indicates drive activity. A connection to the SATA backplane enables this LED to blink on and off when that particular drive is being accessed. Please refer to Chapter 6 for instructions on replacing failed drives.
- **Red:** The red LED indicates a SATA drive failure. If one of the drives fails, you should be notified by your system management software. Please refer to Chapter 6 for instructions on replacing failed drives.

System Safety

This chapter describes basic safety precautions.

Electrical Safety Precautions

Basic electrical safety precautions should be followed to protect yourself from harm and the SGI Rackable C2108-TY10 system from damage, as follows:

- Be aware of the locations of the power on/off switch on the chassis as well as the room's emergency power-off switch, disconnection switch or electrical outlet. If an electrical accident occurs, you can then quickly remove power from the system.
- Do not work alone when working with high voltage components.
- Power should always be disconnected from the system when removing or installing main system components, such as the serverboard, memory modules and SATA drives. When disconnecting power, you should first power down the operating system first and then unplug the power cords. The unit has more than one power supply cord. Disconnect two power supply cords before servicing to avoid electrical shock.
- When working around exposed electrical circuits, another person who is familiar with the power-off controls should be nearby to switch off the power if necessary.
- Use only one hand when working with powered-on electrical equipment. This is to avoid making a complete circuit, which will cause electrical shock. Use extreme caution when using metal tools, which can easily damage any electrical components or circuit boards they come into contact with.
- Do not use mats designed to decrease static electrical discharge as protection from electrical shock. Instead, use rubber mats that have been specifically designed as electrical insulators.
- The power supply power cords must include a grounding plug and must be plugged into grounded electrical outlets.

- Serverboard Battery



Caution: There is a danger of explosion if the onboard battery is installed upside down, which will reverse its polarities (see [Figure 4-1](#)). This battery must be replaced only with the same or an equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions.

- DVD-ROM Laser



Caution: This server may have come equipped with a DVD-ROM drive. To prevent direct exposure to the laser beam and hazardous radiation exposure, do not open the enclosure or use the unit in any unconventional way.

- Mainboard replaceable soldered-in fuses: Self-resetting PTC (Positive Temperature Coefficient) fuses on the mainboard must be replaced by trained service technicians only. The new fuse must be the same or equivalent as the one replaced. Contact technical support for details and support.

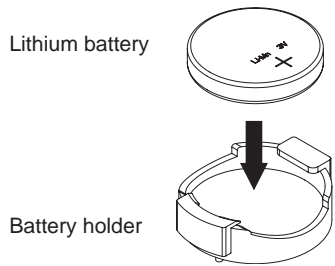


Figure 4-1 Installing the Onboard Battery

General Safety Precautions

Follow these rules to ensure general safety:

- Keep the area around the SGI Rackable C2108-TY10 system clean and free of clutter.
- The SGI Rackable C2108-TY10 system weighs approximately 57 lbs (25.9 kg.) when fully loaded. When lifting the system, two people at either end should lift slowly with their feet spread out to distribute the weight. Always keep your back straight and lift with your legs.

- Place the chassis top cover and any system components that have been removed away from the system or on a table so that they won't accidentally be stepped on.
- While working on the system, do not wear loose clothing such as neckties and unbuttoned shirt sleeves, which can come into contact with electrical circuits or be pulled into a cooling fan.
- Remove any jewelry or metal objects from your body, which are excellent metal conductors that can create short circuits and harm you if they come into contact with printed circuit boards or areas where power is present.
- After accessing the inside of the system, close the system back up and secure it to the rack unit with the retention screws after ensuring that all connections have been made.

ESD Precautions



Caution: Electrostatic discharge (ESD) is generated by two objects with different electrical charges coming into contact with each other. An electrical discharge is created to neutralize this difference, which can damage electronic components and printed circuit boards.

The following measures are generally sufficient to neutralize this difference before contact is made to protect your equipment from ESD:

- Use a grounded wrist strap designed to prevent static discharge.
- Keep all components and printed circuit boards (PCBs) in their antistatic bags until ready for use.
- Touch a grounded metal object before removing the board from the antistatic bag.
- Do not let components or PCBs come into contact with your clothing, which may retain a charge even if you are wearing a wrist strap.
- Handle a board by its edges only; do not touch its components, peripheral chips, memory modules or contacts.
- When handling chips or modules, avoid touching their pins.
- Put the serverboard and peripherals back into their antistatic bags when not in use.
- For grounding purposes, make sure your computer chassis provides excellent conductivity between the power supply, the case, the mounting fasteners and the serverboard.

Advanced Serverboard Setup

This chapter includes procedures to install a node board into the SGI Rackable C2108-TY10 chassis, connect the data and power cables, and install expansion cards.

A layout and quick reference chart is included in this chapter for your reference. See “[Serverboard Quick Reference](#)” on page 32.

Note: Some software products are protected with software license keys derived from the Media Access Control (MAC) Ethernet address. When you replace a node board, the MAC Ethernet address changes. If you are using such a product, you must request a new license key after replacing the node board. Contact your local customer support office

<http://www.sgi.com/support/supportcenters.html>



Caution: Install the chassis cover after you have completed accessing the components inside the server to maintain proper airflow and cooling for the system.

Handling the Node Board



Caution: Electrostatic discharge (ESD) can damage electrostatic-sensitive devices inside the SGI Rackable C2108-TY10 server. Use the ESD precautions described below when you handle printed circuit boards or other components in the system. The following measures are generally sufficient to protect your equipment from electric static discharge.

ESD Precautions

- Use a grounded wrist strap designed to prevent electrostatic discharge.
- Touch a grounded metal object before removing any board from its antistatic bag.
- Handle each printed circuit board (PCB) by the edges; do not touch the components, peripheral chips, memory modules, or gold contacts on the PCB.
- When handling chips or modules, avoid touching the pins.
- Place the node board, expansion PCI cards, or other boards and components into antistatic bags when not in use.
- Make sure your computer chassis provides a conductive path between the power supply, the case, the mounting fasteners, and the node board to chassis ground.

Unpacking



Caution: The node board is shipped in antistatic packaging to avoid electrostatic discharge damage. Be sure to use ESD precautions when you unpack replacement components for the SGI Rackable C2108-TY10 server. Failure to do so can result in damage to the equipment.

Connecting the Control Panel

JF1 contains header pins for various front control panel connectors. See [Figure 5-1](#) for the pin locations of the various front control panel buttons and LED indicators.

All JF1 wires have been bundled into a single cable to simplify this connection. Make sure the red wire plugs into pin 1 as marked on the board. The other end connects to the Control Panel PCB board, located just behind the system status LEDs on the chassis.

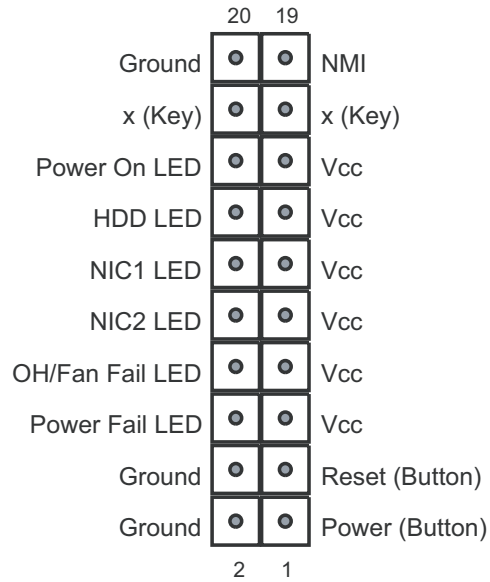


Figure 5-1 Control Panel Header Pins

I/O Ports

The I/O ports are color coded in conformance with the PC 99 specification. See [Figure 5-2](#) below for the colors and locations of the various I/O ports.

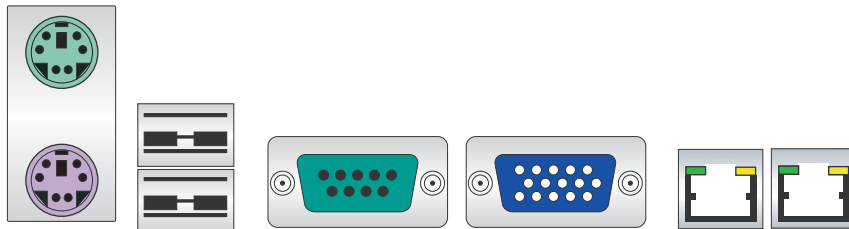


Figure 5-2 I/O Ports Locations

Serverboard Details

The 2U SGI Rackable C2108-TY10 chassis has one node board. It can be configured with 1 or 2 processor sockets. When configuring two processors, the following rules apply:

- Both processor sockets must have identical revisions, core voltage, and bus/core speed.
- The stepping between the two processors on a node board must be identical.
- If only one processor is installed, the single processor socket must be installed in the socket labeled CPU1 (See [Figure 5-3](#)). The other socket remains empty.

See [Figure 5-3](#) for location of CPU 1.

Serverboard Quick Reference

Table 5-1 Jumper Description

Jumper	Description	Default Setting
JBT1	CMOS Clear	See Section 5-10
J12	SMB to PCI-Exp. Slots	Pins 2-3 (Disabled)
J13	SMB to PCI-X Slots	Pins 2-3 (Disabled)
J21	Watch Dog Enable/Disable	Pins 1-2 (Reset)
JP3	IDE Enable/Disable	Pins 1-2 (Enabled)
JPG1	VGA Enable/Disable	Pins 1-2 (Enable)
JPL1	LAN1/2 Enable/Disable	Pins 1-2 (Enabled)

Installing Memory



Caution: Exercise extreme care when installing or removing DIMM modules to prevent any possible damage.

SGI Rackable C2108-TY10 serverboard supports up to 144 GB of DDR3 1333/1066/800 registered ECC SDRAM in 18 DIMM slots. Three-way interleaved memory is supported. For optimal memory performance, install DIMMs three at a time. Use memory modules of the same type and speed. See the following table for memory installation.

Install DIMMs

Perform the following steps to install memory modules, as follows:

1. Insert the DIMM module vertically and press down into its slot until it snaps into place. Pay attention to the alignment notch at the bottom of the module to avoid installing incorrectly (see [Figure 5-4](#) and [Figure 5-5](#)). Insert the desired number of DIMMs into the memory slots, beginning with DIMM #1A and DIMM #2A, then DIMM #3A and DIMM #4A, etc. (see

Table 5-2). Always spread DIMMs across all three banks for each CPU (see [Figure 5-3](#)). Gently press down on the DIMM module until it snaps into place in the slot. Repeat for all modules.

2. To remove a DIMM module, use your thumbs to gently push the release tabs near both ends of the module (see [Figure 5-4](#)). This should release it from the slot (see [Figure 5-6](#)).

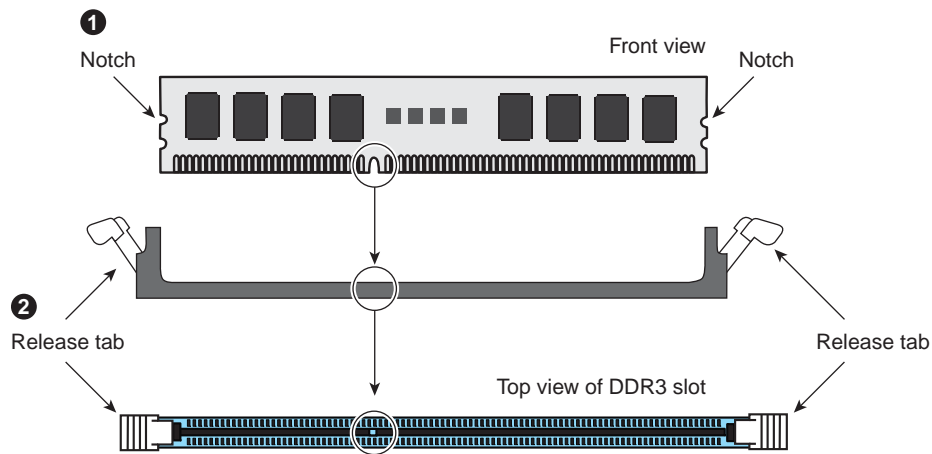


Figure 5-4 DIMM Installation

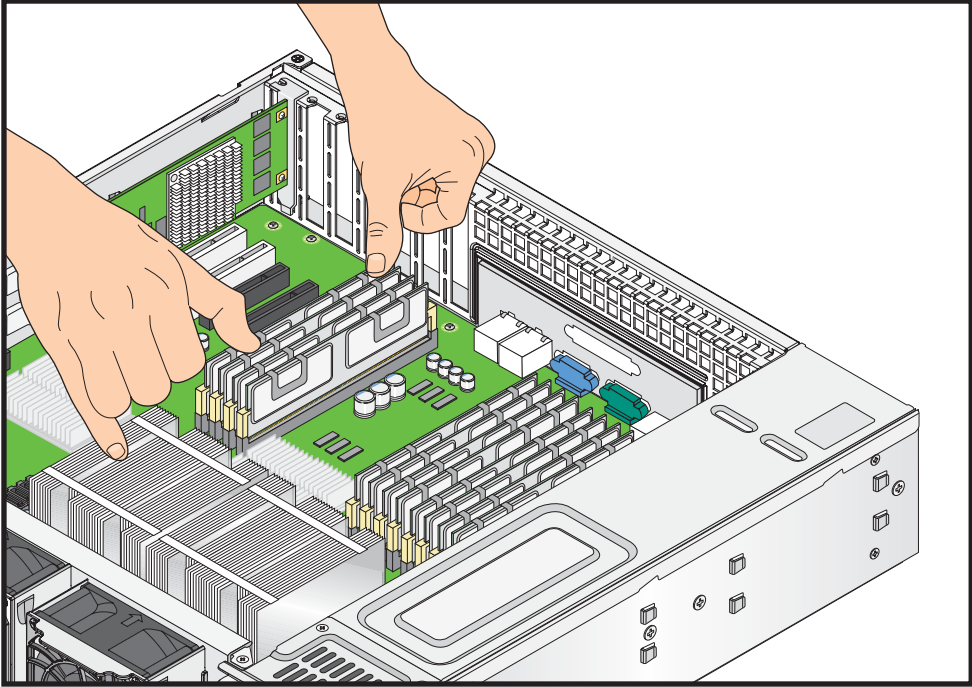


Figure 5-5 Installing DIMM Modules

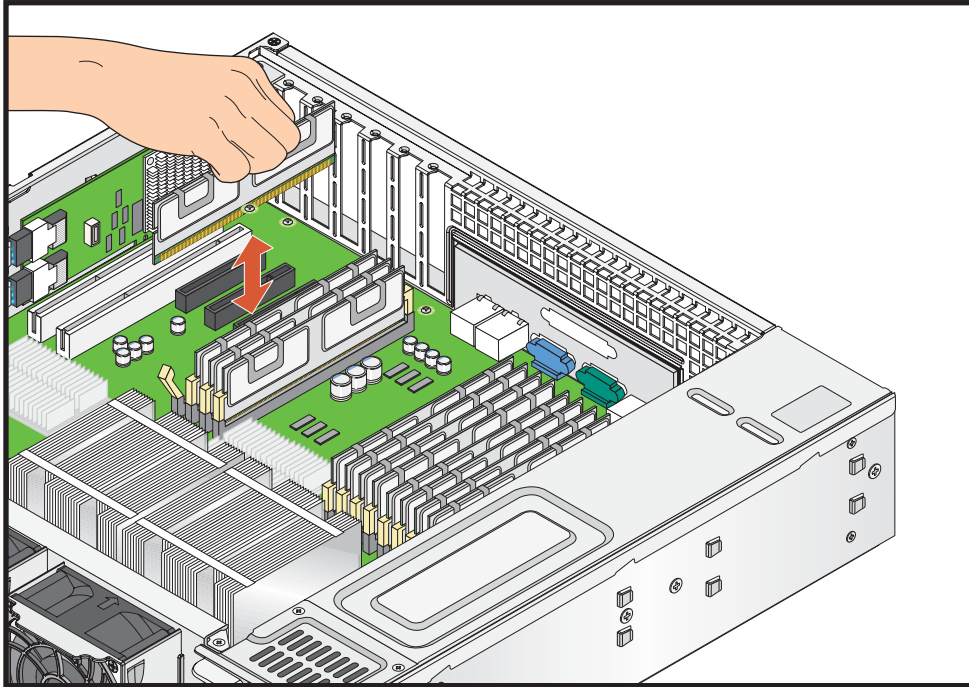


Figure 5-6 Removing a DIMM Module

Memory Configuration

When configured with two processors, the SGI Rackable C2108-TY10 can be configured with a maximum of eighteen memory DIMMs.

Unlike previous processors, the Nehalem-EP processor has the memory controller embedded within the processor socket. There are nine memory DIMMs that are controlled by each processor.

If the node board is configured with only one processor the total number of memory DIMMs supported will be reduced from 18 to 9.

See Figure 5-7 for memory DIMM locations.

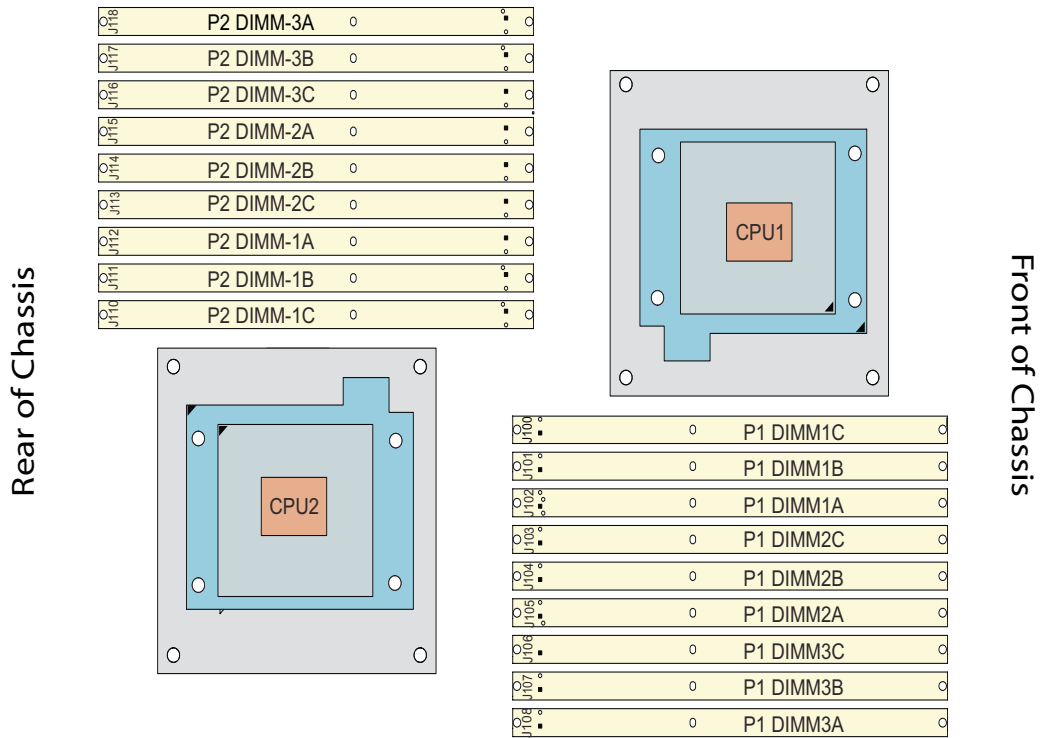


Figure 5-7 Memory DIMM Locations

Memory DIMM Layout

The SGI Rackable C2108-TY10 Nehalem-EP memory controller has three channels with three memory DIMM slots on each channel.

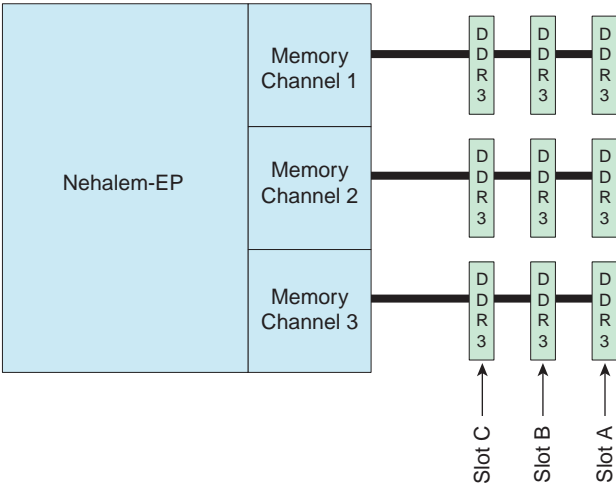


Figure 5-8 Memory Block Diagram

Memory DIMM Rules

Use the following rules when installing memory DIMMs:

The minimum memory allowed on SGI Rackable C2108-TY10 cluster nodes is defined by whether or not the compute nodes are diskless:

- Diskless compute nodes: 8GB per node memory minimum
- Diskful compute nodes: 4GB per node memory minimum

Memory DIMM Rules

- Populate the DIMMs in the furthest slot from the processor for channel 1, first. Then channels 2 - 3.
- A minimum of one DIMM per processor must always be present - one for each processor.
- Mixing DIMM Sizes - When mixing DIMMs on a channel that has a mixed number of ranks, it is recommended to have the total number of ranks on the channel be even to avoid bandwidth degradation. Example: placing a single-rank DIMM and a dual-rank DIMM on the same channel is not desirable. The total number of ranks would be three - an odd number

of ranks. If this option is used, populate the higher ranking DIMMs furthest from the processor (slot A).

- For maximum memory performance the DIMMs within a node must be identical in:
 - Speed (1066 or 1333 Mtransfer/sec)
 - Number of ranks (1 or 2)

Note: The speed of the memory controller will reduce to the lowest speed DIMM on the channel.

- When configuring the memory for maximum performance, it is critical that the memory DIMM capacity is balanced across all memory channels.
- When configuring the memory for maximum performance, it is critical that the memory DIMM capacity is balanced across all memory channels.

Note: The key words are “memory capacity”.

Note: The maximum speed of the memory controller changes based on the number of DIMMs placed on the channel:

- Three DIMMs on the channel the maximum speed supported is 800 MT/s
- Two DIMMs on the channel the maximum speed supported is 1066 MT/s
- One DIMM on the channel the maximum speed supported is 1333 MT/s

Note: Reason for the decrease in memory performance - as more DIMMs are added to a channel the noise on the channel increases and the voltage levels decrease due to signal loading. As a result we have to lower the frequency that we run the channel as more DIMMs are added.

See [Table 5-2](#) for the recommended DIMM configurations that will achieve the maximum memory performance.

Memory DIMM configurations that are describe in [Table 5-3](#) will run with degraded performance.

Mixing Processors and DIMM Speeds

The Nehalem-EP processor is rated for the maximum DIMM speed that it will support. Configuring memory DIMMs that have a DIMM speed that is greater than the processors capability to support will result in the memory DIMM running at the maximum speed of the processor - not the maximum speed of the DIMM. See the following table:

Processor	Memory DIMM	Actual Memory DIMM Speed
1066 MT/s capable CPUs: LSX-CPU-L5520 LSX-CPU-E5520 LSX-CPU-E5530 LSX-CPU-E5540	LSX-MEM-2G-1066 LSX-MEM-4G-1066 LSX-MEM-8G-1066	1066 MT/s (Based on 1 or 2 DIMMs per channel)
1066 MT/s capable CPUs: LSX-CPU-L5520 LSX-CPU-E5520 LSX-CPU-E5530 LSX-CPU-E5540	LSX-MEM-2G-1333 LSX-MEM-4G-1333 LSX-MEM-8G-1333	1066 MT/s (Based on 1 or 2 DIMMs per channel)
1333 MT/s capable CPUs: LSX-CPU-L5550 LSX-CPU-E5560 LSX-CPU-E5570	LSX-MEM-2G-1066 LSX-MEM-4G-1066 LSX-MEM-8G-1066	1066 MT/s (Based on 1 or 2 DIMMs per channel)
1333 MT/s capable CPUs: LSX-CPU-L5550 LSX-CPU-E5560 LSX-CPU-E5570	LSX-MEM-2G-1333 LSX-MEM-4G-1333 LSX-MEM-8G-1333	1333 MT/s (Based on 1 DIMM per channel)

Three conditions must be met to have a memory speed of 1333 MT/s:

- The processor must be capable of supporting 1333 MT/s
- The DIMM must be capable of running at 1333 MT/s
- Only one DIMM is placed on each channel.

Placing three DIMMs on the channel will cause the DIMMs to run at 800 MT/s.

Table 5-2 Recommended Memory DIMM Configurations

Processor 1			Processor 2			Memory/ Core	Total Node Memory Size	Maximum Mem Speed (MT/s)
Channel 1	Channel 2	Channel 3	Channel 1	Channel 2	Channel 3			
1A: 2GB	2A: 2GB	3A: 2GB	1A: 2GB	2A: 2GB	3A: 2GB	1.5 GB/core	12 GB	1333
1B: none	2B: none	3B: none	1B: none	2B: none	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 2GB	2A: 2GB	3A: 2GB	1A: 2GB	2A: 2GB	3A: 2GB	3 GB/core	24 GB	1066
1B: 2GB	2B: 2GB	3B: 2GB	1B: 2GB	2B: 2GB	3B: 2GB			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 4GB	2A: 4GB	3A: 4GB	1A: 4GB	2A: 4GB	3A: 4GB	3 GB/core	24 GB	1333
1B: none	2B: none	3B: none	1B: none	2B: none	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 2GB	2A: 2GB	3A: 2GB	1A: 2GB	2A: 2GB	3A: 2GB	4.5 GB/core	36 GB	800
1B: 2GB	2B: 2GB	3B: 2GB	1B: 2GB	2B: 2GB	3B: 2GB			
1C: 2GB	2C: 2GB	3C: 2GB	1C: 2GB	2C: 2GB	3C: 2GB			
1A: 4GB	2A: 4GB	3A: 4GB	1A: 4GB	2A: 4GB	3A: 4GB	6 GB/core	48 GB	1066
1B: 4GB	2B: 4GB	3B: 4GB	1B: 4GB	2B: 4GB	3B: 4GB			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 8GB	2A: 8GB	3A: 8GB	1A: 8GB	2A: 8GB	3A: 8GB	6 GB/core	48 GB	1333
1B: none	2B: none	3B: none	1B: none	2B: none	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 4GB	2A: 4GB	3A: 4GB	1A: 4GB	2A: 4GB	3A: 4GB	9 GB/core	72 GB	800
1B: 4GB	2B: 4GB	3B: 4GB	1B: 4GB	2B: 4GB	3B: 4GB			
1C: 4GB	2C: 4GB	3C: 4GB	1C: 4GB	2C: 4GB	3C: 4GB			
1A: 8GB	2A: 8GB	3A: 8GB	1A: 8GB	2A: 8GB	3A: 8GB	12 GB/core	96 GB	1066
1B: 8GB	2B: 8GB	3B: 8GB	1B: 8GB	2B: 8GB	3B: 8GB			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			

Table 5-2 Recommended Memory DIMM Configurations **(continued)**

Processor 1			Processor 2			Memory/ Core	Total Node Memory Size	Maximum Mem Speed (MT/s)
Channel 1	Channel 2	Channel 3	Channel 1	Channel 2	Channel 3			
1A: 8GB	2A: 8GB	3A: 8GB	1A: 8GB	2A: 8GB	3A: 8GB	18 GB/core	144 GB	800
1B: 8GB	2B: 8GB	3B: 8GB	1B: 8GB	2B: 8GB	3B: 8GB			
1C: 8GB	2C: 8GB	3C: 8GB	1C: 8GB	2C: 8GB	3C: 8GB			

Table 5-2 Recommended Memory DIMM Configurations **(continued)**

Processor 1			Processor 2			Memory/ Core	Total Node Memory Size	Maximum Mem Speed (MT/s)
Channel 1	Channel 2	Channel 3	Channel 1	Channel 2	Channel 3			
1A: 8GB	2A: 8GB	3A: 8GB	1A: 8GB	2A: 8GB	3A: 8GB	9 GB/core	72 GB	1066
1B: 4GB	2B: 4GB	3B: 4GB	1B: 4GB	2B: 4GB	3B: 4GB			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 8GB	2A: 8GB	3A: 8GB	1A: 8GB	2A: 8GB	3A: 8GB	12 GB/core	96 GB	800
1B: 4GB	2B: 4GB	3B: 4GB	1B: 4GB	2B: 4GB	3B: 4GB			
1C: 4GB	2C: 4GB	3C: 4GB	1C: 4GB	2C: 4GB	3C: 4GB			
1A: 8GB	2A: 8GB	3A: 8GB	1A: 8GB	2A: 8GB	3A: 8GB	15 GB/core	120 GB	800
1B: 8GB	2B: 8GB	3B: 8GB	1B: 8GB	2B: 8GB	3B: 8GB			
1C: 4GB	2C: 4GB	3C: 4GB	1C: 4GB	2C: 4GB	3C: 4GB			

The chart above shows the memory DIMM configurations for the optimum memory performance.

Note: The minimum compute blade memory size is 4GB. The minimum compute memory size is 8GB if the compute blade is in a system running Scali Manage software.

Table 5-3 Non-Optimal Memory DIMM Configurations

Processor 1			Processor 2			Memory/ Core	Total Node Memory Size	Maximum Mem Speed (MT/s)
Channel 1	Channel 2	Channel 3	Channel 1	Channel 2	Channel 3			
1A: 2GB	2A: none	3A: none	1A: 2GB	2A: none	3A: none	0.5 GB/core	4 GB	1333
1B: none	2B: none	3B: none	1B: none	2B: none	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 2GB	2A: 2GB	3A: none	1A: 2GB	2A: 2GB	3A: none	1 GB/core	8 GB	1333
1B: none	2B: none	3B: none	1B: none	2B: none	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 2GB	2A: 2GB	3A: 2GB	1A: 2GB	2A: 2GB	3A: 2GB	2 GB/core	16 GB	1066
1B: 2GB	2B: none	3B: none	1B: 2GB	2B: none	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 2GB	2A: 2GB	3A: 2GB	1A: 2GB	2A: 2GB	3A: 2GB	2.5 GB/core	20 GB	1066
1B: 2GB	2B: 2GB	3B: none	1B: 2GB	2B: 2GB	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 2GB	2A: 2GB	3A: 2GB	1A: 2GB	2A: 2GB	3A: 2GB	3.5 GB/core	28 GB	800
1B: 2GB	2B: 2GB	3B: 2GB	1B: 2GB	2B: 2GB	3B: 2GB			
1C: 2GB	2C: none	3C: none	1C: 2GB	2C: none	3C: none			
1A: 2GB	2A: 2GB	3A: 2GB	1A: 2GB	2A: 2GB	3A: 2GB	4 GB/core	32 GB	800
1B: 2GB	2B: 2GB	3B: 2GB	1B: 2GB	2B: 2GB	3B: 2GB			
1C: 2GB	2C: 2GB	3C: none	1C: 2GB	2C: 2GB	3C: none			
1A: 4GB	2A: none	3A: none	1A: 4GB	2A: none	3A: none	1 GB/core	8 GB	1333
1B: none	2B: none	3B: none	1B: none	2B: none	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 4GB	2A: 4GB	3A: none	1A: 4GB	2A: 4GB	3A: none	2 GB/core	16 GB	1333
1B: none	2B: none	3B: none	1B: none	2B: none	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			

Table 5-3 Non-Optimal Memory DIMM Configurations (continued)

Processor 1			Processor 2			Memory/ Core	Total Node Memory Size	Maximum Mem Speed (MT/s)
Channel 1	Channel 2	Channel 3	Channel 1	Channel 2	Channel 3			
1A: 4GB	2A: 4GB	3A: 4GB	1A: 4GB	2A: 4GB	3A: 4GB	4 GB/core	32 GB	1066
1B: 4GB	2B: none	3B: none	1B: 4GB	2B: none	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 4GB	2A: 4GB	3A: 4GB	1A: 4GB	2A: 4GB	3A: 4GB	5 GB/core	40 GB	1066
1B: 4GB	2B: 4GB	3B: none	1B: 4GB	2B: 4GB	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 4GB	2A: 4GB	3A: 4GB	1A: 4GB	2A: 4GB	3A: 4GB	7 GB/core	56 GB	800
1B: 4GB	2B: 4GB	3B: 4GB	1B: 4GB	2B: 4GB	3B: 4GB			
1C: 4GB	2C: none	3C: none	1C: 4GB	2C: none	3C: none			
1A: 4GB	2A: 4GB	3A: 4GB	1A: 4GB	2A: 4GB	3A: 4GB	8 GB/core	64 GB	800
1B: 4GB	2B: 4GB	3B: 4GB	1B: 4GB	2B: 4GB	3B: 4GB			
1C: 4GB	2C: 4GB	3C: none	1C: 4GB	2C: 4GB	3C: none			
1A: 8GB	2A: none	3A: none	1A: 8GB	2A: none	3A: none	2 GB/core	16 GB	1333
1B: none	2B: none	3B: none	1B: none	2B: none	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 8GB	2A: 8GB	3A: none	1A: 8GB	2A: 8GB	3A: none	4 GB/core	32 GB	1333
1B: none	2B: none	3B: none	1B: none	2B: none	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 8GB	2A: 8GB	3A: 8GB	1A: 8GB	2A: 8GB	3A: 8GB	8 GB/core	64 GB	1066
1B: 8GB	2B: none	3B: none	1B: 8GB	2B: none	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 8GB	2A: 8GB	3A: 8GB	1A: 8GB	2A: 8GB	3A: 8GB	10 GB/core	80 GB	1066
1B: 8GB	2B: 8GB	3B: none	1B: 8GB	2B: 8GB	3B: none			
1C: none	2C: none	3C: none	1C: none	2C: none	3C: none			
1A: 8GB	2A: 8GB	3A: 8GB	1A: 8GB	2A: 8GB	3A: 8GB	14 GB/core	112 GB	800
1B: 8GB	2B: 8GB	3B: 8GB	1B: 8GB	2B: 8GB	3B: 8GB			
1C: 8GB	2C: none	3C: none	1C: 8GB	2C: none	3C: none			

Table 5-3 Non-Optimal Memory DIMM Configurations (continued)

Processor 1			Processor 2			Memory/ Core	Total Node Memory Size	Maximum Mem Speed (MT/s)
Channel 1	Channel 2	Channel 3	Channel 1	Channel 2	Channel 3			
1A: 8GB	2A: 8GB	3A: 8GB	1A: 8GB	2A: 8GB	3A: 8GB	16 GB/core	128 GB	800
1B: 8GB	2B: 8GB	3B: 8GB	1B: 8GB	2B: 8GB	3B: 8GB			
1C: 8GB	2C: 8GB	3C: none	1C: 8GB	2C: 8GB	3C: none			
1A: 8GB	2A: 8GB	3A: 8GB	1A: 8GB	2A: 8GB	3A: 8GB	18 GB/core	144 GB	800
1B: 8GB	2B: 8GB	3B: 8GB	1B: 8GB	2B: 8GB	3B: 8GB			
1C: 8GB	2C: 8GB	3C: 8GB	1C: 8GB	2C: 8GB	3C: 8GB			

Hard Disk Drives (SGI Rackable C2108-TY10 Chassis)

The 2U chassis supports a maximum of eight SAS or SATA disk drives. Install the drives from left to right. Note: All disk drive bays must be populated to maintain system thermals. Drive bays must either have a disk drive or a drive blank installed.

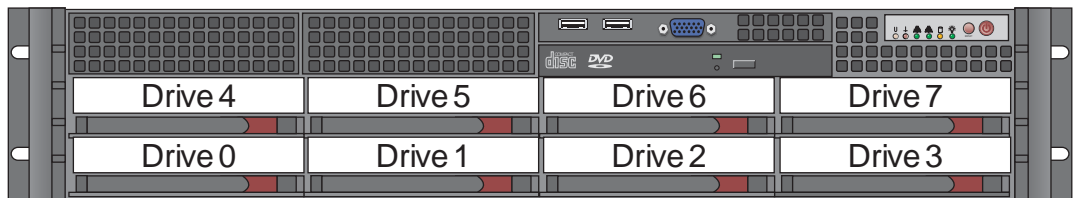


Figure 5-9 SGI Rackable C2108-TY10 Disk Drive Locations

The supported disk drive configurations are as follows:

- **LSX-CONFIG-JBOD**
JBOD, supports any number of drives between one and eight. The operating system is placed on the disk drive in location 0. All other drives are data drives.
- **LSX-CONFIG-RAID0**
Disk striping without parity, supports any number of drives between two and eight. Note: all drives must be the same type. The operating system will be striped across all drives in the system. This configuration is not recommended.

- **RAID1**
Disk mirroring, supports exactly two drives. The two drives represents one RAID1 logical drive. The operating system will be installed on the drives located in Drive 0 and 1. Note: Both drives must be the same type.
- **RAID5**
Disk striping with parity, supports a minimum of three drives and a maximum of eight drives. Possible configurations are 2+1, 3+1, 4+1, 5+1, 6+1 and 7+1. The operating system will be striped across all drives in the system. Note: all drives must be the same type
- **RAID6**
Disk striping with dual parity, supports a minimum of four drives and a maximum of eight drives. The operating system will be striped across all drives in the system. Note: all drives must be the same type
- **RAID10**
Mirrored disk striping, the data is striped across one set of drives and then mirrored on another set of drives. A minimum of four drives of the same type are required. The total number of drives must be an even number (4, 6, 8). A total of four drives is a 2+2, six drives is a 3+3, and eight drives is a 4+4. The operating system will be striped across all drives in the primary set and then mirrored on the secondary set of drives. Note: all drives must be the same type

PCI Card Slotting

There are three basic configurations of the SGI Rackable C2108-TY10:

- No RAID card installed
- L8i RAID card installed
- H8iR RAID card installed

The available PCI slots for the above three configurations are as follows::

- Configuration 1: (three PCIe and 3 PCI-X slots open)
- Configurations 2 and 3: (three PCIe and 2 PCI-X slots open -slot 1 is blocked)

Note: PCI-X slot 1 is blocked when configurations 2 and 3 are used.

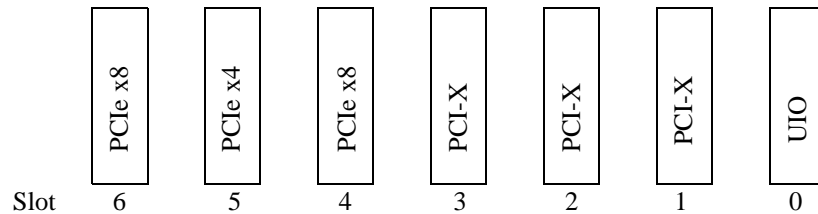


Figure 5-10 Base PCI card configuration

For consistency use the following configuration rules for slotting optional PCI cards:

- PCIe InfiniBand card - use either slot 4 or slot 6
- PCI-X GigE card - use either slot 2 or slot 3

The SGI Rackable C2108-TY10 PCI slots are configured as follows:

- Slot 0 - UIO
- Slot 1 – PCI-X 133 MHz (this slot will be blocked when a either the L8i or H8iR RAID card is installed in the UIO slot.)
- Slot 2 – PCI-X 133 MHz (slot 2 shares the PCI-X bus with slot 1)
- Slot 3 – PCI-X 133 MHz
- Slot 4 – PCIe x8 Gen2
- Slot 5 – PCIe x4 Gen1
- Slot 6– PCIe x8 Gen2

Note: Both the L8i and H8iR RAID cards use the UIO slot.

Installing Selected PCI cards

PCIe Transfer Rates

PCIe Gen1 supports the following maximum bandwidths per slot:

- Gen1 PCIe runs at 2.5 GT/s (GT/s = GigaTransfers per second)
- Supports a maximum of 250 MB/s/lane
- X4 = 1GB/s maximum transfer rate in each direction

- X8 = 2GB/s maximum transfer rate in each direction

PCIe Gen2 supports the following maximum bandwidths per slot:

- Gen2 PCIe runs at 5.0 GT/s (GT/s = GigaTransfers per second)
- Supports a maximum of 500 MB/s/lane
- X4 = 2GB/s maximum transfer rate in each direction
- X8 = 4GB/s maximum transfer rate in each direction

Installing PCI-X cards

There are three PCI-X slots: slots 1 and 2 share a single bus, slot 3 has a dedicated bus. The maximum bandwidth, if both slots 1 and 2 are filled, is 1024 MB/s for both slots combined.

If either of the RAID options are selected, then slot 1 will not be available. The remaining two PCI-X slots are equal. For consistency, fill slot 2 first.

If the RAID options are not selected, then all three PCI-X slots will be available. Slot 3 will each support 1024 MB/s, but slots 1 and 2 share a single bus and therefore the total bandwidth available to both slots is 1024 MB/s. When slotting PCI-X card, make sure to place the highest bandwidth card in slot 3.

Installing PCIe cards

Use the following guidelines:

- Install Gen2 PCI cards in slots 4 and 6. Fill slot 4 first then slot 6.
- Install Gen 1 PCI cards in slot 5.

Power Supply

The default configuration is a single 720 watt power supply. The single power supply is slotted in the top power bay slot. A second (redundant) 720 watt power supply can be added to the server in the lower slot.

A dummy power supply must be installed in the lower power bay when the server is configured with a single power supply.

Advanced Chassis Setup

This chapter covers the steps required to install components and perform maintenance on the SGI Rackable C2108-TY10 chassis shown in [Figure 6-1](#). For component installation, follow the steps in the order given to eliminate the most common problems encountered. If some steps are unnecessary, skip ahead to the step that follows.

Tools Required: The only tool you will need to install components and perform maintenance is a Philips screwdriver.

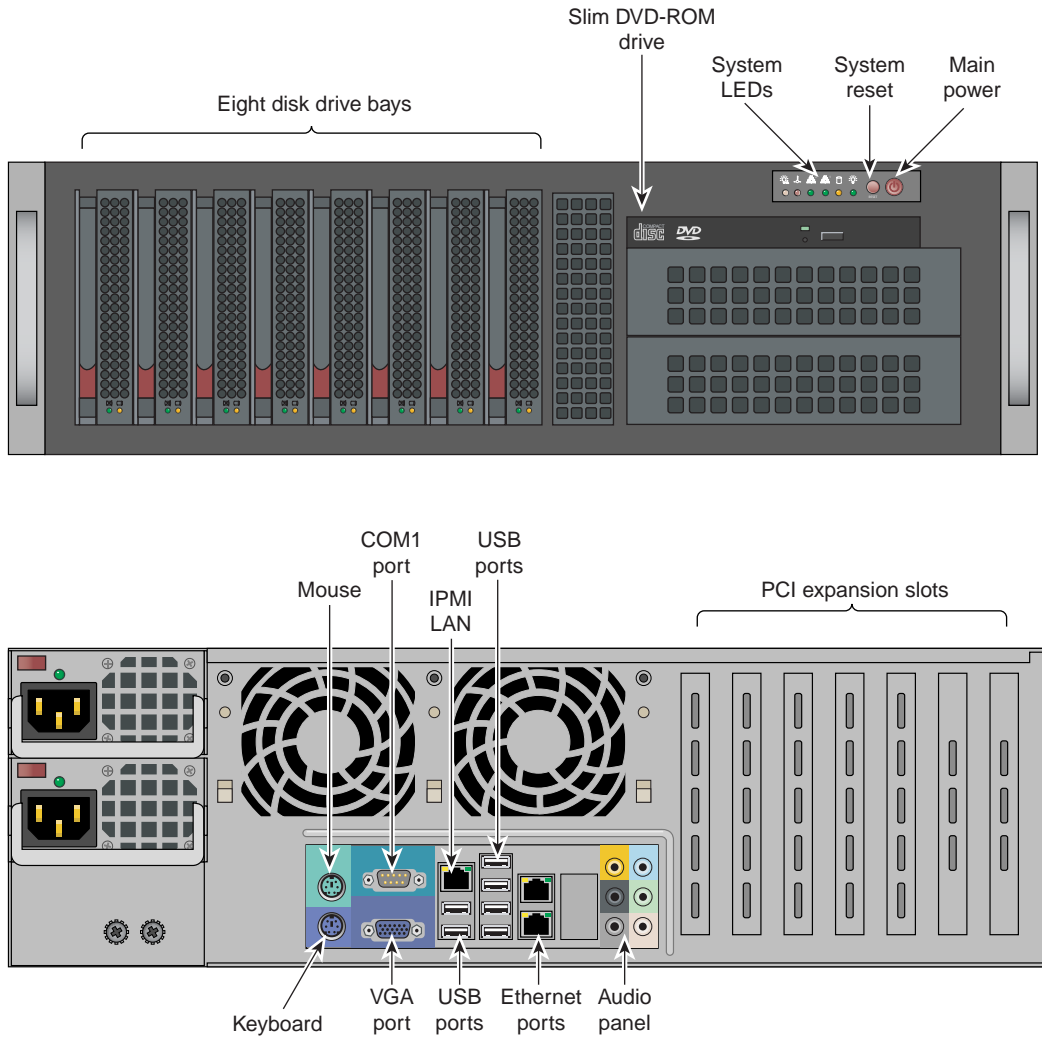


Figure 6-1 Front and Rear Chassis Views

Static-Sensitive Device

Electrostatic discharge (ESD) can damage electronic components. To prevent damage to any printed circuit boards (PCBs), it is important to handle them very carefully. The following measures are generally sufficient to protect your equipment from ESD damage.

Precautions

- Use a grounded wrist strap designed to prevent static discharge.
- Touch a grounded metal object before removing any board from its antistatic bag.
- Handle a board by its edges only; do not touch its components, peripheral chips, memory modules or gold contacts.
- When handling chips or modules, avoid touching their pins.
- Put the serverboard, add-on cards and peripherals back into their antistatic bags when not in use.
- For grounding purposes, make sure your computer chassis provides excellent conductivity between the power supply, the case, the mounting fasteners and the serverboard.

Unpacking

The serverboard is shipped in antistatic packaging to avoid static damage. When unpacking the board, make sure the person handling it is static protected.

Control Panel

The control panel (located on the front of the chassis) must be connected to the JF1 connector on the serverboard to provide you with system status indications. A ribbon cable has bundled these wires together to simplify the connection. Connect the cable from JF1 on the serverboard to the Control Panel PCB (printed circuit board). Make sure the red wire plugs into pin 1 on both connectors. Pull all excess cabling out of the airflow path. The LEDs inform you of system status. See Chapter 3 for details on the LEDs and the control panel buttons. Details on JF1 can be found in Chapter 5.

System Fans

Three 8-cm hot-swap fans provide the cooling for the system. It is very important that the chassis top cover is properly installed and making a good seal in order for the cooling air to circulate properly through the chassis and cool the components. See Figure 6-2.

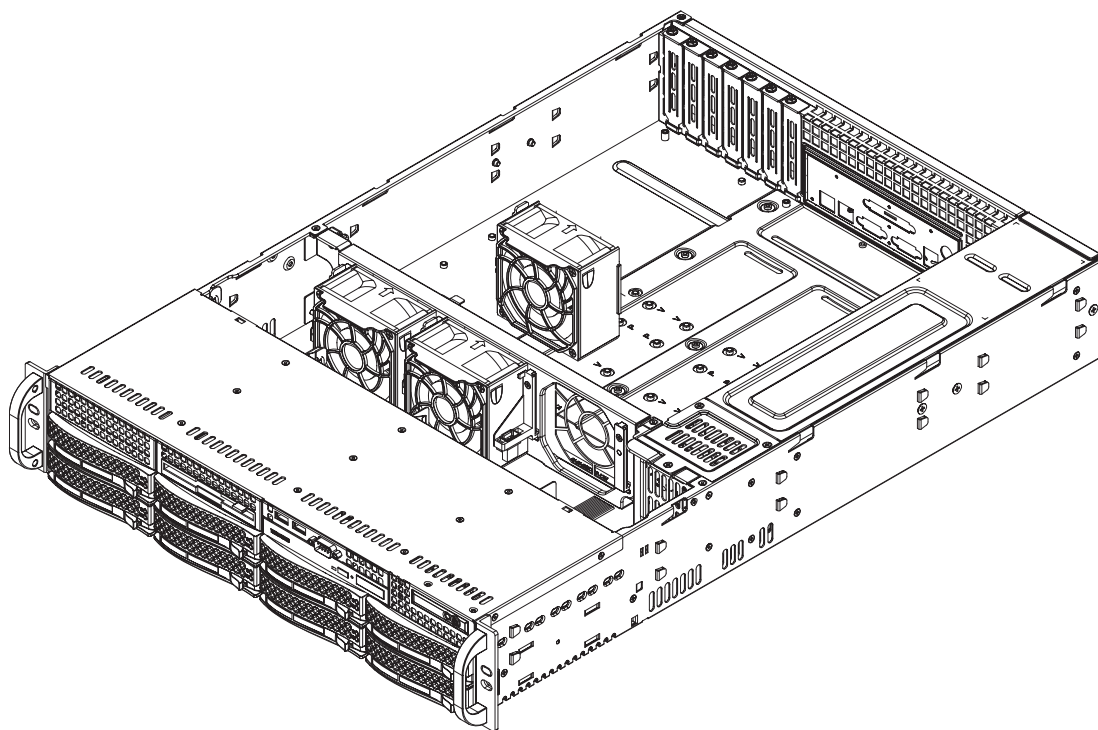


Figure 6-2 Removing System Cooling Fans

System Fan Failure

Fan speed is controlled by system temperature via a BIOS setting. If a fan fails, the remaining fans will ramp up to full speed and the overheat/fan fail LED on the control panel will turn on. Replace any failed fan at your earliest convenience with the same type and model (the system can continue to run with a failed fan). Remove the top chassis cover while the system is still running to determine which of the fans has failed.

Replacing System Fans

This section describes how to remove or install a system fan.

Removing a Fan

1. Remove the chassis cover.
2. Press the tabs on the sides of the fan to unlock and remove the fan and its housing. The fan's power connections will automatically detach.
3. System power does not need to be shut down since the fans are hot-pluggable.

Installing a New Fan

1. Replace the failed fan with an identical 8-cm, 12 volt fan.
2. Position the new fan into the space vacated by the failed fan previously removed. A "click" can be heard when the fan is fully installed in place and the power connections are made.
3. If the system power is on, the hot-plug feature will cause the fan to start immediately upon being connected to its header on the serverboard.

Drive Bay Installation/Removal

This section describes drive bay installation and removal.

Accessing the Drive Bays

SATA Drives: You do not need to access the inside of the chassis or remove power to replace or swap SATA drives. Proceed to the next step for instructions.

Note: You must use standard 1" high, SATA drives in the system.

DVD-ROM Drive: For installing/removing the DVD-ROM disk drive, you will need to gain access to the inside of the server by removing the top cover of the chassis. Proceed to the "DVD-ROM Drive Installation" section later in this chapter for instructions.

SATA Drive Installation

The SATA drives are mounted in drive carriers to simplify their installation and removal from the chassis. These carriers also help promote proper airflow for the drives. For this reason, even empty carriers without hard drives installed must remain in the chassis.

Mounting a SATA Drive in a Drive Carrier

1. To add a new SATA drive, install the drive into the carrier with the printed circuit board side facing down so that the mounting holes align with those in the carrier.
2. Secure the drive to the carrier with four screws, as shown in [Figure 6-3](#).

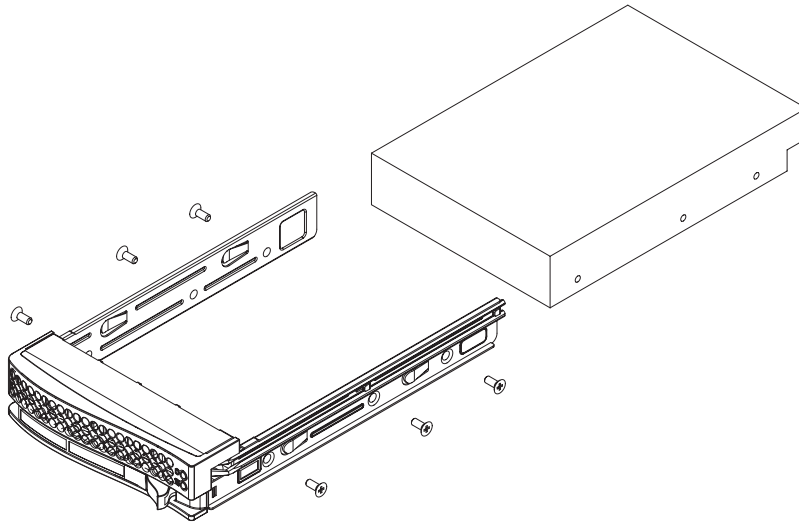


Figure 6-3 Mounting a SATA Drive in a Carrier

Installing/Removing Hot-swap SATA Drives

1. Push the release button located beside the drive's LEDs.
2. Swing the handle fully out and use it to pull the drive carrier straight out (see [Figure 6-4](#)).

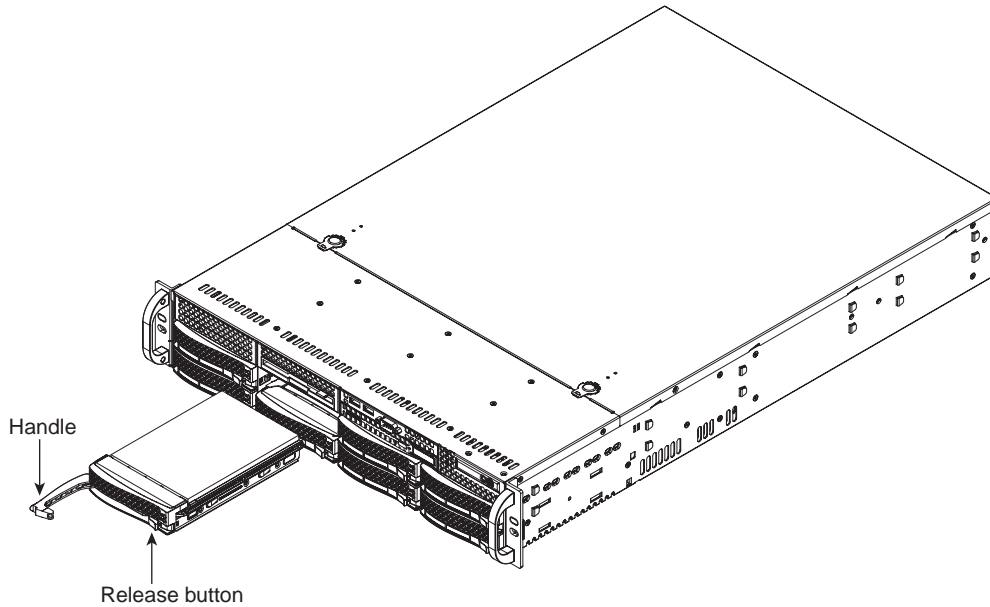


Figure 6-4 Removing SATA Drive Carrier

Note: Your operating system must have RAID support to enable the hot-plug capability of the drives.



Important: Regardless of how many hard drives are installed, all drive carriers must remain in the drive bays to maintain proper airflow.



Caution: Use caution when working around the SATA backplane. Do not touch the backplane with any metal objects and make sure no ribbon cables touch the backplane or obstruct the holes, which aid in proper airflow.

Hard Drive Backplane

The hard drives plug into a backplane that provides power, drive ID and bus termination. A RAID controller can be used with the backplane to provide data security. The operating system you use must have RAID support to enable the hot-swap capability of the hard drives. The backplane is already preconfigured, so no jumper or switch configurations are required.

DVD-ROM Drive Installation

The top cover of the chassis must be opened to gain full access to the DVD-ROM drive bays. The SGI Rackable C2108-TY10 system accommodates only slim type DVD-ROM drives. Side mounting brackets are typically needed to mount a slim DVD-ROM drive in the server.

Accessing the Inside of the Chassis

1. Grasp the two handles on either side and pull the unit straight out until it locks (you will hear a "click").
2. Next, depress the two buttons on the top of the chassis to release the top cover and at the same time, push the cover away from you until it stops. You can then lift the top cover from the chassis to gain full access to the inside of the server.

Note: You must power down the system before installing or removing IDE components.

Drives mount on rails and should "click" into place to be correctly and fully installed in their bays.

Power Supply

The SGI Rackable C2108-TY10 system has a 720 watt redundant power supply consisting of two power modules. Each power supply module has an auto-switching capability, which enables it to automatically sense and operate at a 100V - 240V input voltage.

Power Supply Failure

If either of the two power supply modules fail, the other module will take the full load and allow the system to continue operation without interruption. The PWR Fail LED will illuminate and

remain on until the failed unit has been replaced. The power supply units have a hot-swap capability, meaning you can replace the failed unit without powering down the system.

Removing/Replacing the Power Supply

You do not need to shut down the system to replace a power supply unit. The backup power supply module will keep the system up and running while you replace the failed hot-swap unit. Replace with the same model.

Removing the Power Supply

1. First unplug the AC power cord from the failed power supply module.
2. Depress the locking tab on the power supply module.
3. Use the handle to pull it straight out with the rounded handle.

Installing a New Power Supply

1. Replace the failed hot-swap unit with another identical power supply unit.
2. Push the new power supply unit into the power bay until you hear a click.
3. Secure the locking tab on the unit.
4. Finish by plugging the AC power cord back into the unit.

BIOS

This chapter describes the AMI BIOS Setup Utility for the SGI Rackable C2108-TY10 severboard. The AMI ROM BIOS is stored in a Flash EEPROM and can be easily updated. This chapter describes the basic navigation of the AMI BIOS Setup Utility setup screens.

Starting BIOS Setup Utility

To enter the AMI BIOS Setup Utility screens, press the <Delete> key while the system is booting up.

Note: In most cases, the <Delete> key is used to invoke the AMI BIOS setup screen. There are a few cases when other keys are used, such as <F1>, <F2>, etc.

Each main BIOS menu option is described in this manual. The Main BIOS setup menu screen has two main frames. The left frame displays all the options that can be configured. Grayed-out options cannot be configured. Options in blue can be configured by the user. The right frame displays the key legend. Above the key legend is an area reserved for a text message. When an option is selected in the left frame, it is highlighted in white. Often a text message will accompany it.

Note: The AMI BIOS has default text messages built in. These text messages may be included, omitted, or changed across BIOS releases.

The AMI BIOS Setup Utility uses a key-based navigation system called "hot keys". Most of the AMI BIOS setup utility "hot keys" can be used at any time during the setup navigation process. These keys include <F1>, <F10>, <Enter>, <ESC>, arrow keys, etc.

Note: Options printed in Bold are default settings.

How To Change the Configuration Data

The configuration data that determines the system parameters may be changed by entering the AMI BIOS Setup utility. This Setup utility can be accessed by pressing at the appropriate time during system boot.

Starting the Setup Utility

Normally, the only visible Power-On Self-Test (POST) routine is the memory test. As the memory is being tested, press the <Delete> key to enter the main menu of the AMI BIOS Setup Utility. From the main menu, you can access the other setup screens. An AMI BIOS identification string is displayed at the left bottom corner of the screen below the copyright message.



Warning: Do not upgrade the BIOS unless your system has a BIOS-related issue. Flashing the wrong BIOS can cause irreparable damage to the system. In no event shall Supermicro be liable for direct, indirect, special, incidental, or consequential damages arising from a BIOS update. If you have to update the BIOS, do not shut down or reset the system while the BIOS is updating. This is to avoid possible boot failure.

Main Setup

When you first enter the AMI BIOS Setup Utility, you will enter the Main setup screen. You can always return to the Main setup screen by selecting the Main tab on the top of the screen. The Main BIOS Setup screen is shown in [Figure 7-1](#).

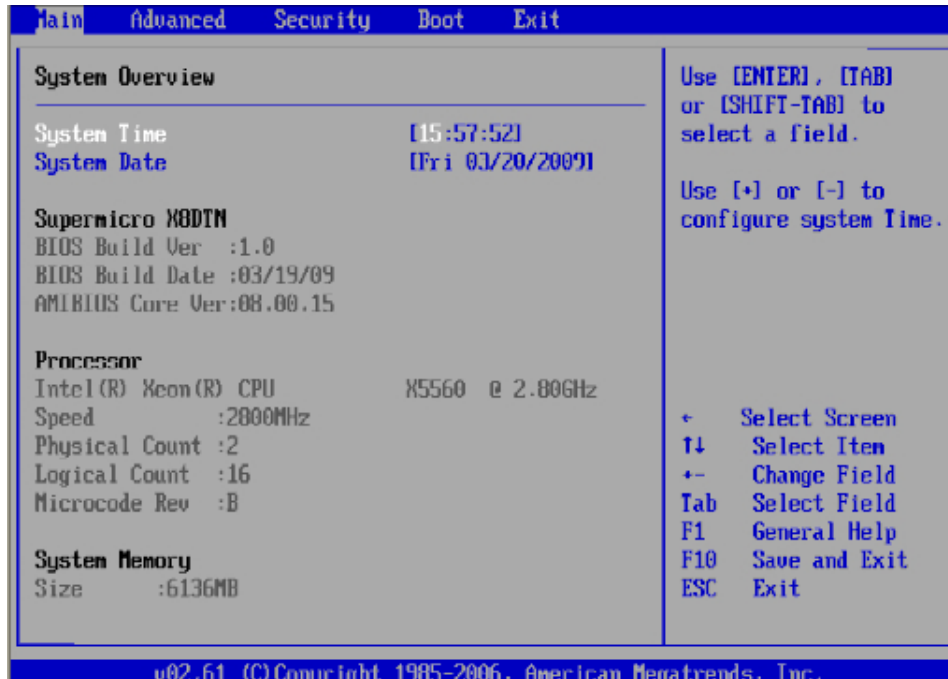


Figure 7-1 System Overview Main BIOS Setup Screen

System Time/System Update

Use this option to change the system time and date. Highlight System Time or System. Date using the arrow keys. Key in new values through the keyboard and press <Enter>. Press the <Tab> key to move between fields. The date must be entered in Day MM/DD/YY format. The time is entered in HH:MM:SS format.

Note: The time is in the 24-hour format. For example, 5:30 P.M. appears as 17:30:00.

Serverboard

- **BIOS Build Version:** This item displays the BIOS revision used in your system.

- **BIOS Build Date:** This item displays the date when this BIOS was completed.
- **AMI BIOS Core Version:** This item displays the revision number of the AMI BIOS Core upon which your BIOS was built.

Processor

The AMI BIOS will automatically display the status of the processor used in your system:

- **CPU Type:** This item displays the type of CPU used in the motherboard.
- **Speed:** This item displays the speed of the CPU detected by the BIOS.
- **Physical Count:** This item displays the number of processors installed in your system as detected by the BIOS.
- **Logical Count:** This item displays the number of CPU Cores installed in your system as detected by the BIOS.
- **Micro_code Revision:** This item displays the revision number of the BIOS Micro_code used in your system.

System Memory

This displays the size of memory available in the system:

- **Size:** This item displays the memory size detected by the BIOS

Advanced Setup Configurations

Use the arrow keys to select Boot Setup and hit <Enter> to access the submenu items shown in [Figure 7-2](#).

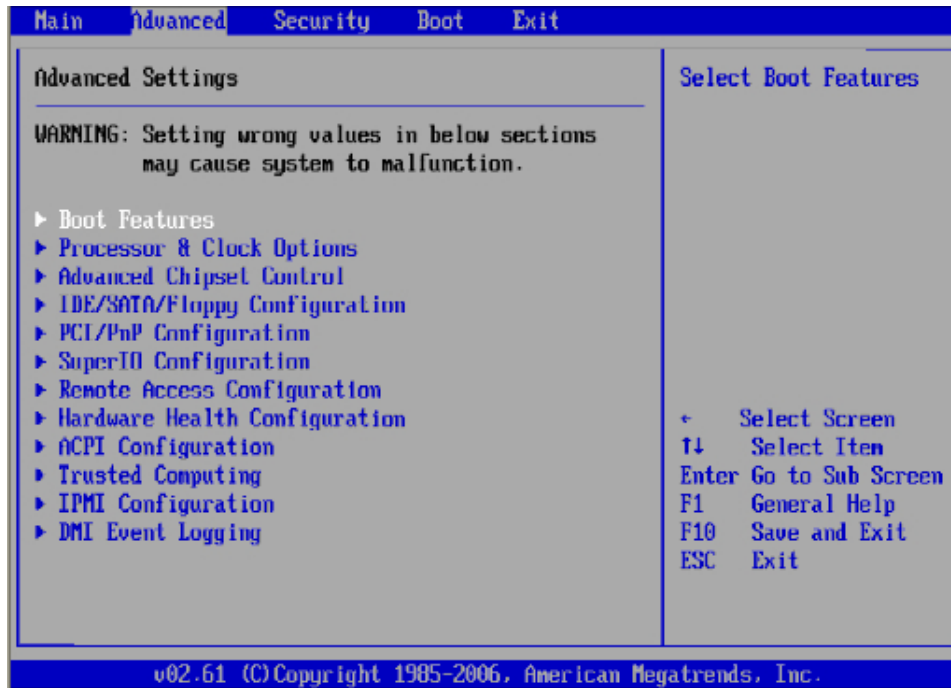


Figure 7-2 Advanced Settings Screen

Boot Features

This section describes the **Boot Features** options.

Quick Boot

If Enabled, this option will skip certain tests during POST to reduce the time needed for system boot. The options are **Enabled** and Disabled.

Note: The default option is highlighted in bold face throughout this chapter.

Quiet Boot

This option allows the bootup screen options to be modified between POST messages or the OEM logo. Select Disabled to display the POST messages. Select Enabled to display the OEM logo instead of the normal POST messages. The options are **Enabled** and Disabled.

AddOn ROM Display Mode

This sets the display mode for Option ROM. The options are **Force BIOS** and Keep Current.

Bootup Num-Lock

This feature selects the Power-on state for Numlock key. The options are Off and **On**.

Wait For 'F1' If Error

This forces the system to wait until the 'F1' key is pressed if an error occurs. The options are Disabled and **Enabled**.

Hit 'Del' Message Display

This feature displays "Press DEL to run Setup" during POST. The options are **Enabled** and Disabled.

Interrupt 19 Capture

Interrupt 19 is the software interrupt that handles the boot disk function. When this item is set to Enabled, the ROM BIOS of the host adaptors will "capture" Interrupt 19 at boot and allow the drives that are attached to these host adaptors to function as bootable disks. If this item is set to Disabled, the ROM BIOS of the host adaptors will not capture Interrupt 19, and the drives attached to these adaptors will not function as bootable devices. The options are Enabled and **Disabled**.

Power Configuration

This section describes power configuration options.

Power Button Function

If set to `Instant_Off`, the system will power off immediately as soon as the user hits the power button. If set to `4_Second_Override`, the system will power off when the user presses the power button for 4 seconds or longer. The options are **Instant_Off** and `4_Second_Override`.

Restore on AC Power Loss

Use this feature to set the power state after a power outage. Select `Power-Off` for the system power to remain off after a power loss. Select `Power-On` for the system power to be turned on after a power loss. Select `Last State` to allow the system to resume its last state before a power loss. The options are `Power-On`, `Power-Off` and **Last State**.

Watch Dog Timer

If enabled, the Watch Dog Timer will allow the system to reboot when it is inactive for more than 5 minutes. The options are `Enabled` and **Disabled**.

Processor and Clock Options

This submenu allows the user to configure the Processor and Clock settings.

Ratio CMOS Setting

This option allows the user to set the ratio between the CPU Core Clock and the FSB Frequency.

Note: If an invalid ratio is entered, the AMI BIOS will restore the setting to the previous state.

The default setting depends on the type of CPU installed on the motherboard. The default setting for the CPU installed in your motherboard is **[21]**. Press "+" or "-" on your keyboard to change this value.

C1E Support

Select `Enabled` to use the feature of Enhanced Halt State. C1E significantly reduces the CPU's power consumption by reducing the CPU's clock cycle and voltage during a "Halt State." The options are `Disabled` and **Enabled**.

Hardware Prefetcher (Available when supported by the CPU)

If set to Enabled, the hardware prefetcher will pre fetch streams of data and instructions from the main memory to the L2 cache in the forward or backward manner to improve CPU performance. The options are Disabled and **Enabled**.

Adjacent Cache Line Prefetch (Available when supported by the CPU)

The CPU fetches the cache line for 64 bytes if this option is set to Disabled. The CPU fetches both cache lines for 128 bytes as comprised if **Enabled**.

Intel Virtualization Technology (Available when supported by the CPU)

Select Enabled to use the feature of Virtualization Technology to allow one platform to run multiple operating systems and applications in independent partitions, creating multiple "virtual" systems in one physical computer. The options are **Enabled** and Disabled.

Note: If there is any change to this setting, you will need to power off and restart the system for the change to take effect. Please refer to Intel's web site for detailed information.

Execute-Disable Bit Capability (Available when supported by the OS and the CPU)

Set to Enabled to enable the Execute Disable Bit which will allow the processor to designate areas in the system memory where an application code can execute and where it cannot, thus preventing a worm or a virus from flooding illegal codes to overwhelm the processor or damage the system during an attack. The default is **Enabled**. (Refer to Intel and Microsoft Web Sites for more information.)

Simultaneous Multi-Threading (Available when supported by the CPU)

Set to Enabled to use the Simultaneous Multi-Threading Technology, which will result in increased CPU performance. The options are Disabled and **Enabled**.

Active Processor Cores

Set to Enabled to use a processor's Second Core and beyond. (Please refer to Intel's web site for more information.) The options are **All**, 1 and 2.

Intel EIST Technology

Enhanced Intel SpeedStep Technology (EIST) allows the system to automatically adjust processor voltage and core frequency in an effort to reduce power consumption and heat dissipation. Please refer to Intel's web site for detailed information. The options are **Disable (Disable GV3)** and **Enable (Enable GV3)**.

Intel TurboMode Technology (Available when Intel EIST Technology is enabled)

Select Enabled to use the Turbo Mode to boost system performance. The options are **Enabled** and **Disabled**.

Intel C-STATE Tech

If enabled, C-State is set by the system automatically to either C2, C3 or C4 state. The options are **Disabled** and **Enabled**.

C-State package limit setting (Available when Intel® C-State Tech is enabled)

If set to Auto, the AMI BIOS will automatically set the limit on the C-State package register. The options are **Auto**, C1, C3, C6 and C7.

C1 Auto Demotion

When enabled, the CPU will conditionally demote C3, C6 or C7 requests to C1 based on un-core auto-demote information. The options are **Disabled** and **Enabled**.

C3 Auto Demotion

When enabled, the CPU will conditionally demote C6 or C7 requests to C3 based on un-core auto-demote information. The options are **Disabled** and **Enabled**.

Clock Spread Spectrum

Select Enable to use the feature of Clock Spectrum, which will allow the BIOS to monitor and attempt to reduce the level of Electromagnetic Interference caused by the components whenever needed. The options are **Disabled** and **Enabled**.

Advanced Chipset Control

The items included in the Advanced Settings submenu are listed below:

CPU Bridge Configuration

QPI Links Speed

This feature selects QPI's data transfer speed. The options are Slow-mode, and **Full Speed**.

QPI Frequency

This selects the desired QPI frequency. The options are **Auto**, 4.800 GT, 5.866GT, 6.400 GT.

QPI L0s and L1

This enables the QPI power state to low power. L0s and L1 are automatically selected by the motherboard. The options are **Disabled** and Enabled.

Memory Frequency

This feature forces a DDR3 frequency slower than what the system has detected. The available options are **Auto**, Force DDR-800, Force DDR-1066, and Force DDR-1333.

Memory Mode

The options are **Independent**, Channel Mirror, Lockstep and Sparing.

Independent - All DIMMs are available to the operating system.

Channel Mirror - The motherboard maintains two identical copies of all data in memory for redundancy.

Lockstep - The motherboard uses two areas of memory to run the same set of operations in parallel.

Sparing - A preset threshold of correctable errors is used to trigger fail-over. The spare memory is put online and used as active memory in place of the failed memory.

Demand Scrubbing

A memory error-correction scheme where the Processor writes corrected data back into the memory block from where it was read by the Processor. The options are Enabled and **Disabled**.

Patrol Scrubbing

A memory error-correction scheme that works in the background looking for and correcting resident errors. The options are Enabled and **Disabled**.

Memory ECC Error Threshold

This feature allows the user to set the correctable memory ECC error limit for AMI BIOS to handle it. The Default setting is 255.

Throttling - Closed Loop/Throttling - Open Loop

Throttling improves reliability and reduces power in the processor by automatic voltage control during processor idle states. Available options are **Disabled** and Enabled. If Enabled, the following items will appear:

Hysteresis Temperature (Available for Closed Loop only)

Temperature Hysteresis is the temperature lag (in degrees Celsius) after the set DIMM temperature threshold is reached before Closed Loop Throttling begins. The options are Disabled, **1.5oC**, 3.0oC, and 6.0oC.

Guardband Temperature (Available for Closed Loop only)

This is the temperature which applies to the DIMM temperature threshold. Each step is in 0.5oC increment. The default is **[006]**. Press "+" or "-" on your keyboard to change this value.

Inlet Temperature

This is the temperature detected at the chassis inlet. Each step is in 0.5oC increment. The default is **[070]**. Press "+" or "-" on your keyboard to change this value.

Temperature Rise

This is the temperature rise to the DIMM thermal zone. Each step is in 0.5oC increment. The default is **[020]**. Press "+" or "-" on your keyboard to change this value.

Air Flow

This is the air flow speed to the DIMM modules. Each step is one mm/ sec. The default is [1500]. Press "+" or "-" on your keyboard to change this value.

Altitude

This feature defines how many meters above or below sea level the system is located. The options are **Sea Level or Below**, 1~300, 301~600, 601~900, 901~1200, 1201~1500, 1501~1800, 1801~2100, 2101~2400, 2401~2700, 2701~3000.

DIMM Pitch

This is the physical space between each DIMM module. Each step is in 1/1000 of an inch. The default is [400]. Press "+" or "-" on your keyboard to change this value.

Serial Debug Message Level

This feature allows the user to set the level of debug messages to be displayed. The options are **None**, MIN, MAX and Test.

North Bridge Configuration

This feature allows the user to configure the settings for the Intel North Bridge chip.

Crystal Beach/Direct Memory Access (DMA)

This feature works with the Intel I/O Acceleration Technology (AT) to accelerate the performance of TOE devices.

Note: A TOE device is a specialized, dedicated processor that is installed on an add-on card or a network card to handle some or all packet processing of this add-on card.

When this feature is set to Enabled, it will enhance overall system performance by providing direct memory access for data transferring. The options are Enabled and **Disabled**.

Crystal Beach/ Direct Cache Access (DCA)

This feature is available when Crystal Beach/DMA is enabled. This feature works in conjunction with the Intel I/O AT to accelerate the performance of the TOE device. When this feature set to Enabled, it will enhance overall system performance by providing direct cache access for data transferring. The options are Enabled and **Disabled**.

Intel VT-d

Select Enabled to enable Intel's Virtualization Technology support for Direct I/O VT-d by reporting the I/O device assignments to VMM through the DMAR ACPI Tables.

This feature offers fully-protected I/O resource-sharing across the Intel platforms, providing the user with greater reliability, security and availability in networking and data-sharing. The settings are Enabled and **Disabled**.

SouthBridge Configuration

This feature allows the user to configure the settings for the Intel ICH South Bridge chipset.

USB Functions

This feature allows the user to decide the number of onboard USB ports to be enabled. The Options are: Disabled, 2 USB ports, 4 USB ports, 6 USB ports, 8 Ports, 10 Ports and **12 USB ports**.

Legacy USB Support

Select Enabled to use Legacy USB devices. If this item is set to Auto, Legacy USB support will be automatically enabled if a legacy USB device is installed on the motherboard, and vice versa. The settings are Disabled, **Enabled** and Auto.

USB 2.0 Controller

This item indicated if the USB 2.0 controller is activated. The options are Enabled and Disabled.

USB 2.0 Controller Mode

This setting allows you to select the USB 2.0 Controller mode. The options are Hi-Speed (480 Mbps) and **Full Speed (12 Mbps)**.

BIOS EHCI Hand-Off

Select Enabled to enable BIOS Enhanced Host Controller Interface support to provide a workaround solution for an operating system that does not have EHCI Hand-Off support. When enabled, the EHCI Interface will be changed from the BIOS-controlled to the OS-controlled. The options are Disabled and **Enabled**.

Intel PCI-X Hub Configuration

PCI Bus A0/B0 Frequency

This option allows the user to set the maximum PCI speed to be used in the PCI slot specified. Select Auto to allow the BIOS to automatically detect the capability of the device installed on the bus. The options are **Auto**, 33 MHz PCI, 66 MHz PCI, 66 MHz PCI-X MI, 100 MHz PCI-X MI, and 133 MHz PCI-X MI.

I/O Port Decode

This option allows the user to select the decode range for the I/O connections. The options are **4K Decode** and 1K Decode.

RAS Sticky Error Handling

This option allows the user to decide how to handle Sticky RAS errors. The options are **Clear Errors** and Leave Errors (unchanged).

VGA 16-Bit Decode

Select Enabled to enable the function of decoding VGA for the devices installed behind the PXH PCI Controller Hub. The options are **Enabled** and Disabled.

IDE and SATA Configuration

When this submenu is selected, the AMI BIOS automatically detects the presence of the IDE devices and displays the following items:

SATA#1 Configuration

If Compatible is selected, it sets SATA#1 to legacy compatibility mode, while selecting Enhanced sets SATA#1 to native SATA mode. The options are Disabled, **Compatible**, and Enhanced.

Configure SATA#1 as

This feature allows the user to select the drive type for SATA#1. The options are **IDE**, RAID and AHCI. (When the option-RAID is selected, the item-ICH RAID Code Base will appear. When the option-AHCI is selected, the item-SATA AHCI will be available.)

ICH RAID Code Base (This feature is available when the option-RAID is selected)

Select Intel to enable Intel's SATA RAID firmware to configure Intel's SATA RAID settings. Select Adaptec to enable Adaptec's SATA RAID firmware to configure Adaptec's SATA RAID settings. The options are **Intel** and Adaptec.

SATA AHCI (This feature is available when the option-AHCI is selected)

Select Enable to enable the function of Serial ATA Advanced Host Interface. (Take caution when using this function. This feature is for advanced programmers only.) The options are Enabled and Disabled. If the option-Enabled is selected, the following item will display.

SATA#2 Configuration (This feature is available when the option-IDE is selected)

Selecting Enhanced will set SATA#2 to native SATA mode. The options are Disabled, and **Enhanced**.

Primary IDE Settings

Primary IDE Master/Slave, Secondary IDE Master/Slave, Third IDE Master, and Fourth IDE Master

These settings allow the user to set the parameters of Primary IDE Master/Slave, Secondary IDE Master/Slave, Third and Fourth IDE Master slots. Hit <Enter> to activate the following

submenu screen for detailed options of these items. Set the correct configurations accordingly. The items included in the submenu are:

Type

Select the type of device connected to the system. The options are Not Installed, **Auto**, CD/DVD and ARMD.

LBA/Large Mode

LBA (Logical Block Addressing) is a method of addressing data on a disk drive. In the LBA mode, the maximum drive capacity is 137 GB. For drive capacities over 137 GB, your system must be equipped with a 48-bit LBA mode addressing. If not, contact your manufacturer or install an ATA/133 IDE controller card that supports 48-bit LBA mode. The options are Disabled and **Auto**.

Block (Multi-Sector Transfer)

Block Mode boosts the IDE drive performance by increasing the amount of data transferred. Only 512 bytes of data can be transferred per interrupt if Block Mode is not used. Block Mode allows transfers of up to 64 KB per interrupt. Select Disabled to allow data to be transferred from and to the device one sector at a time. Select Auto to allow data transfer from and to the device occur multiple sectors at a time if the device supports it. The options are **Auto** and Disabled.

PIO Mode

The IDE PIO (Programmable I/O) Mode programs timing cycles between the IDE drive and the programmable IDE controller. As the PIO mode increases, the cycle time decreases. The options are Auto, 0, 1, 2, 3, and 4.

Select Auto to allow the AMI BIOS to automatically detect the PIO mode. Use this value if the IDE disk drive support cannot be determined.

Select 0 to allow the AMI BIOS to use PIO mode 0. It has a data transfer rate of 3.3 MBs.

Select 1 to allow the AMI BIOS to use PIO mode 1. It has a data transfer rate of 5.2 MBs.

Select 2 to allow the AMI BIOS to use PIO mode 2. It has a data transfer rate of 8.3 MBs.

Select 3 to allow the AMI BIOS to use PIO mode 3. It has a data transfer rate of 11.1 MBs.

Select 4 to allow the AMI BIOS to use PIO mode 4. It has a data transfer bandwidth

of 32-Bits. Select Enabled to enable 32-Bit data transfer.

DMA Mode

Select Auto to allow the BIOS to automatically detect IDE DMA mode when the IDE disk drive support cannot be determined.

Select SWDMA0 to allow the BIOS to use Single Word DMA mode 0. It has a data transfer rate of 2.1 MBs.

Select SWDMA1 to allow the BIOS to use Single Word DMA mode 1. It has a data transfer rate of 4.2 MBs.

Select SWDMA2 to allow the BIOS to use Single Word DMA mode 2. It has a data transfer rate of 8.3 MBs.

Select MWDMA0 to allow the BIOS to use Multi Word DMA mode 0. It has a data transfer rate of 4.2 MBs.

Select MWDMA1 to allow the BIOS to use Multi Word DMA mode 1. It has a data transfer rate of 13.3 MBs.

Select MWDMA2 to allow the BIOS to use Multi-Word DMA mode 2. It has a data transfer rate of 16.6 MBs.

Select UDMA0 to allow the BIOS to use Ultra DMA mode 0. It has a data transfer rate of 16.6 MBs. It has the same transfer rate as PIO mode 4 and Multi Word DMA mode 2.

Select UDMA1 to allow the BIOS to use Ultra DMA mode 1. It has a data transfer rate of 25 MBs.

Select UDMA2 to allow the BIOS to use Ultra DMA mode 2. It has a data transfer rate of 33.3 MBs.

Select UDMA3 to allow the BIOS to use Ultra DMA mode 3. It has a data transfer rate of 66.6 MBs.

Select UDMA4 to allow the BIOS to use Ultra DMA mode 4. It has a data transfer rate of 100 MBs.

Select UDMA5 to allow the BIOS to use Ultra DMA mode 5. It has a data transfer rate of 133 MBs.

Select UDMA6 to allow the BIOS to use Ultra DMA mode 6. It has a data transfer rate of 133 MBs. The options are Auto, SWDMAn, MWDMAn, and UDMAn.

S.M.A.R.T. For Hard disk drives

Self-Monitoring Analysis and Reporting Technology (SMART) can help predict impending drive failures. Select Auto to allow the AMI BIOS to automatically detect hard disk drive support. Select Disabled to prevent the AMI BIOS from using the S.M.A.R.T. Select Enabled to allow the AMI BIOS to use the S.M.A.R.T. to support hard drive disk. The options are Disabled, Enabled, and **Auto**.

32Bit Data

Select Enable to enable the function of 32-bit IDE data transfer. The options are **Enabled** and Disabled.

Hot Plug

This feature is available when the option-AHCI Under "Configure SATA#1 as" is selected.

Select Enable to enable the hot plug function for the SATA devices. The options are **Enabled** and Disabled.

IDE Detect Timeout (sec)

Use this feature to set the time-out value for the BIOS to detect the ATA, ATAPI devices installed in the system. The options are 0 (sec), 5, 10, 15, 20, 25, 30, and **35**.

PCI/PnP Configuration

Clear NVRAM

This feature clears the NVRAM during system boot. The options are **No** and Yes.

Plug & Play OS

Selecting Yes allows the OS to configure Plug & Play devices. (This is not required for system boot if your system has an OS that supports Plug & Play.) Select **No** to allow the AMI BIOS to configure all devices in the system.

PCI Latency Timer

This feature sets the latency Timer of each PCI device installed on a PCI bus. Select 64 to set the PCI latency to 64 PCI clock cycles. The options are 32, **64**, 96, 128, 160, 192, 224 and 248.

PCI IDE BusMaster

When enabled, the BIOS uses PCI bus mastering for reading/writing to IDE drives. The options are Disabled and **Enabled**.

Load Onboard LAN1 Option ROM/Load Onboard LAN2 Option ROM

Select Enabled to enable the onboard LAN1 or LAN2 Option ROM. This is to boot computer using a network interface. The options are Enabled and **Disabled**.

Super IO Device Configuration

Serial Port1 Address/ Serial Port2 Address

This option specifies the base I/O port address and the Interrupt Request address of Serial Port 1 and Serial Port 2. Select Disabled to prevent the serial port from accessing any system resources. When this option is set to Disabled, the serial port physically becomes unavailable. Select 3F8/IRQ4 to allow the serial port to use 3F8 as its I/O port address and IRQ 4 for the interrupt address. The options for Serial Port1 are Disabled, 3F8/IRQ4, 3E8/IRQ4, 2E8/IRQ3. The options for Serial Port2 are Disabled, 2F8/IRQ3, 3E8/IRQ4, and 2E8/IRQ3.

Remote Access Configuration

Remote Access

This allows the user to enable the Remote Access feature. The options are Disabled and **Enabled**.

If Remote Access is set to Enabled, the following items will display:

Serial Port Number

This feature allows the user decide which serial port to be used for Console Redirection. The options are **COM 1** and COM 2.

Base Address, IRQ

This item displays the based address and IRQ of the serial port specified above. The options are **COM 1** and **COM 2**.

Serial Port Mode

This feature allows the user to set the serial port mode for Console Redirection. The options are **115200 8, n 1**; **57600 8, n, 1**; **38400 8, n, 1**; **19200 8, n, 1**; and **9600 8, n, 1**.

Flow Control

This feature allows the user to set the flow control for Console Redirection. The options are **None**, **Hardware**, and **Software**.

Redirection After BIOS POST

Select **Disabled** to turn off Console Redirection after Power-On Self-Test (POST). Select **Always** to keep Console Redirection active all the time after POST.

Note: This setting may not be supported by some operating systems.

Select **Boot Loader** to keep Console Redirection active during POST and Boot Loader. The options are **Disabled**, **Boot Loader**, and **Always**.

Terminal Type

This feature allows the user to select the target terminal type for Console Redirection. The options are **ANSI**, **VT100**, and **VT-UTF8**.

VT-UTF8 Combo Key Support

A terminal keyboard definition that provides a way to send commands from a remote console. Available options are **Enabled** and **Disabled**.

Sredir Memory Display Delay

This feature defines the length of time in seconds to display memory information. The options are **No Delay**, **Delay 1 Sec**, **Delay 2 Sec**, and **Delay 4 Sec**.

Hardware Health Monitor

This feature allows the user to monitor system health and review the status of each item as displayed.

CPU Overheat Alarm

This option allows the user to select the CPU Overheat Alarm setting which determines when the CPU OH alarm will be activated to provide warning of possible CPU overheat.



Warning: Any temperature that exceeds the CPU threshold temperature predefined by the CPU manufacturer may result in CPU overheat or system instability. When the CPU temperature reaches this predefined threshold, the CPU and system cooling fans will run at full speed. To avoid possible system overheating, please be sure to provide adequate airflow to your system.

The options are:

- The Early Alarm: Select this setting if you want the CPU overheat alarm (including the LED and the buzzer) to be triggered as soon as the CPU temperature reaches the CPU overheat threshold as predefined by the CPU manufacturer.
- The Default Alarm: Select this setting if you want the CPU overheat alarm including the LED and the buzzer) to be triggered when the CPU temperature reaches about 5 degrees C above the threshold temperature as predefined by the CPU manufacturer to give the CPU and system fans additional time needed for CPU and system cooling. In both the alarms above, please take immediate action as shown below.

CPU Temperature/System Temperature

This feature displays current temperature readings for the CPU and the System.

The following items will be displayed for your reference only:

CPU Temperature

The CPU thermal technology that reports absolute temperatures (Celsius/Fahrenheit) has been upgraded to a more advanced feature by Intel in its newer processors. The basic concept is each CPU is embedded by unique temperature information that the motherboard can read. This 'Temperature Threshold' or 'Temperature Tolerance' has been assigned at the factory and is the

baseline on which the motherboard takes action during different CPU temperature conditions (for example, by increasing CPU Fan speed, triggering the Overheat Alarm, etc). Since CPUs can have different ‘Temperature Tolerances’, the installed CPU can now send information to the motherboard what its ‘Temperature Tolerance’ is, and not the other way around. This results in better CPU thermal management.

The SGI Rackable C2108-TY10 system leverages this feature by assigning a temperature status to certain thermal conditions in the processor (Low, Medium and High). This makes it easier for the user to understand the CPU’s temperature status, rather than by just simply seeing a temperature reading (for example, 25 degrees C). The CPU Temperature feature will display the CPU temperature status as detected by the BIOS:

Low – This level is considered as the ‘normal’ operating state. The CPU temperature is well below the CPU ‘Temperature Tolerance’. The motherboard fans and CPU will run normally as configured in the BIOS (Fan Speed Control).

User intervention: No action required.

Medium – The processor is running warmer. This is a ‘precautionary’ level and generally means that there may be factors contributing to this condition, but the CPU is still within its normal operating state and below the CPU ‘Temperature Tolerance’. The motherboard fans and CPU will run normally as configured in the BIOS. The fans may adjust to a faster speed depending on the Fan Speed Control settings.

User intervention: No action is required. However, consider checking the CPU fans and the chassis ventilation for blockage.

High – The processor is running hot. This is a ‘caution’ level since the CPU’s ‘Temperature Tolerance’ has been reached (or has been exceeded) and may activate an overheat alarm.

User intervention: If the system buzzer and Overheat LED has activated, take action immediately by checking the system fans, chassis ventilation and room temperature to correct any problems.

Note: The system may shut down if it continues for a long period to prevent damage to the CPU. The information provided above is for your reference only. For more information on thermal management, please refer to Intel’s web site at www.intel.com.

System Temperature

The system temperature will be displayed (in degrees in Celsius and Fahrenheit) as it is detected by the BIOS.

Fan Speed Readings

This feature displays the fan speed readings from Fan1 through Fan8.

Fan Speed Control Monitor

This feature allows the user to decide how the system controls the speeds of the onboard fans. The CPU temperature and the fan speed are correlative. When the CPU on-die temperature increases, the fan speed will also increase, and vice versa. Select Workstation if your system is used as a Workstation. Select Server if your system is used as a Server. Select “Disabled, (Full Speed @ 12V)” to disable the fan speed control function and allow the onboard fans to constantly run at the full speed (12V). The Options are: 1. **Disabled (Full Speed)**, 2. Server Mode, 3. Workstation Mode.

Voltages Readings

The following voltage readings will be displayed.

CPU1 Vcore, CPU2 Vcore, +5Vin, +12V, -12V 3.3Vcc (V), and Battery Voltage

ACPI Configuration

Use this feature to configure Advanced Configuration and Power Interface (ACPI) power management settings for your system.

ACPI Version Features

The options are ACPI v1.0, ACPI v2.0 and ACPI v3.0. Please refer to ACPI's website for further explanation: <http://www.acpi.info/>.

ACPI APIC Support

Select Enabled to include the ACPI APIC Table Pointer in the RSDT (Root System Description Table) pointer list. The options are **Enabled** and Disabled.

APIC ACPI SCI IRQ

When this item is set to Enabled, APIC ACPI SCI IRQ is supported by the system. The options are Enabled and **Disabled**.

Headless Mode

This feature is used to enable system to function without a keyboard, monitor or mouse attached. The options are Enabled and **Disabled**.

High Performance Event Timer

Select Enabled to activate the High Performance Event Timer (HPET) that produces periodic interrupts at a much higher frequency than a Real-time Clock (RTC) does in synchronizing multimedia streams, providing smooth playback and reducing the dependency on other timestamp calculation devices, such as an x86 RDTSC Instruction embedded in the CPU. The High Performance Event Timer is used to replace the 8254 Programmable Interval Timer. The options are Enabled and **Disabled**.

Trusted Computing

TCG/TPM Support

Select Yes on this item and enable the TPM jumper on the motherboard to enable TCG (TPM 1.1/1.2)/TPM support in order to improve data integrity and network security. The options are **No** and **Yes**.

If this feature is set to Yes, the following items will display:

TPM Enable/Disable Status

This item displays the status of TPM Support to indicate if TPM is currently enabled or disabled.

TPM Owner Status

This item displays the status of TPM Ownership.

IPMI Configuration

Intelligent Platform Management Interface (IPMI) is a set of common interfaces that IT administrators can use to monitor system health and to manage the system as a whole. For more information on the IPMI specifications, please visit Intel's website at www.intel.com.

Status of BMC

Baseboard Management Controller (BMC) manages the interface between system management software and platform hardware. This is an informational feature which returns the status code of the BMC micro controller.

View BMC System Event Log

This feature displays the BMC System Event Log (SEL). It shows the total number of entries of BMC System Events. To view an event, select an Entry Number and pressing <Enter> to display the information as shown in the screen.

- Total Number of Entries
- SEL Entry Number
- SEL Record ID
- SEL Record Type
- Timestamp, Generator ID
- Event Message Format User
- Event Sensor Type
- Event Sensor Number
- Event Dir Type
- Event Data

Clear BMC System Event Log

Select OK and press the <Enter> key to clear the BMC system log. Select Cancel to keep the BMC System log. The options are OK and Cancel.



Caution: Any cleared information is unrecoverable. Make absolutely sure that you no longer need any data stored in the log before clearing the BMC Event Log.

Set LAN Configuration

Set this feature to configure the IPMI LAN adapter with a network address as shown in the following graphics.

Channel Number - Enter the channel number for the SET LAN Config command. This is initially set to [1]. Press "+" or "-" on your keyboard to change the Channel Number.

Channel Number Status -This feature returns the channel status for the Channel Number selected above: "Channel Number is OK" or "Wrong Channel Number".

IP Address Configuration

Enter the IP address for this machine. This should be in decimal and in dotted quad form (i.e., 192.168.10.253). The value of each three-digit number separated by dots should not exceed 255 as shown in the screen below.

Parameter Selector

Use this feature to select the parameter of your IP Address configuration.

IP Address

The BIOS will automatically enter the IP address of this machine; however it may be over-written. IP addresses are 6 two-digit hexadecimal numbers (Base 16, 0 ~ 9, A, B, C, D, E, F) separated by dots. (for example, 00.30.48.D0.D4.60).

Current IP Address in BMC

This item displays the current IP address used for your IPMI connection.

MAC Address Configuration

Enter the Mac address for this machine. This should be in decimal and in dotted quad form (for example, 192.168.10.253). The value of each three-digit number separated by dots should not exceed 255.

Parameter Selector

Use this feature to select the parameter of your Mac Address configuration.

Mac Address

The BIOS will automatically enter the Mac address of this machine; however, it may be over-ridden. Mac addresses are 6 two-digit hexadecimal numbers (Base 16, 0 ~ 9, A, B, C, D, E, F) separated by dots. (i.e., 00.30.48.D0.D4.60).

Current Mac Address in BMC

This item displays the current Mac address used for your IPMI connection.

Subnet Mask Configuration

Subnet masks tell the network which subnet this machine belongs to. The value of each three-digit number separated by dots should not exceed 255.

Parameter Selector

Use this feature to select the parameter of your Subnet Masks configuration.

Subnet Mask

This item displays the current subnet mask setting for your IPMI connection.

SEL PEF Configuration

PEF Support

Select Enabled to enable the function of Platform Event Filter (PEF) which will interpret BMC events and perform actions based on pre-determined settings or events and performs actions based on pre-determined settings or 'traps' under IPMI 1.5 specifications. For example, powering the system down or sending an alert when a triggering event is detected. The default is **Disabled**.

PEF Action Global Control

Note: Available if the item-PEF Support is enabled.

These are the different actions based on BMC events. The options are Alert, Power Down, Reset System, Power Cycle, OEM Action, Diagnostic Interface.

Alert Startup Delay

Note: Available if the item-PEF Support is enabled.

This feature inserts a delay during startup for PEF alerts. The options are Enabled and **Disabled**.

PEF Alert Startup Delay

Note: Available if the item-PEF Support is enabled.

This sets the pre-determined time to delay PEF alerts after system power-ups and resets. Refer to Table 24.6 of the IPMI 1.5 Specification for more information at www.intel.com. The options are **No Delay**, 30 sec, 60 sec, 1.5 min, 2.0 min.

Startup Delay

Note: Available if the item-PEF Support is enabled.

This feature enables or disables startup delay. The options are Enabled and **Disabled**.

PEF Startup Delay

Note: Available if the item-PEF Startup is enabled.

This sets the pre-determined time to delay PEF after system power-ups and resets. Refer to Table 24.6 of the IPMI 1.5 Specification for more information at www.intel.com. The options are No Delay, 30 sec, 60 sec, 1.5 min, 2.0 min.

Event Message for PEF Action

Note: Available if the item-PEF Support is enabled.

This enables or disables Event Messages for PEF action. Refer to Table 24.6 of the IPMI 1.5 Specification for more information at www.intel.com. The options are **Disabled** and Enabled.

BMC Watch Dog Timer Action

Allows the BMC to reset or power down the system if the operating system hangs or crashes. The options are Disabled, Reset System, Power Down, Power Cycle.

BMC Watch Dog TimeOut [Min:Sec]

This option appears if BMC Watch Dog Timer Action (above) is enabled. This is a timed delay in minutes or seconds, before a system power down or reset after an operating system failure is detected. The options are [**5 Min**], [1 Min], [30 Sec], and [10 Sec].

DMI Event Log

View Event Log

Use this option to view the System Event Log.

Mark all events as read

This option marks all events as read. The options are OK and Cancel.

Clear event log

This option clears the Event Log memory of all messages. The options are OK and **Cancel**.

Security Settings

The AMIBIOS Setup Utility provides a Supervisor and a User password. If you use both passwords, the Supervisor password must be set first. See Figure 7-3.

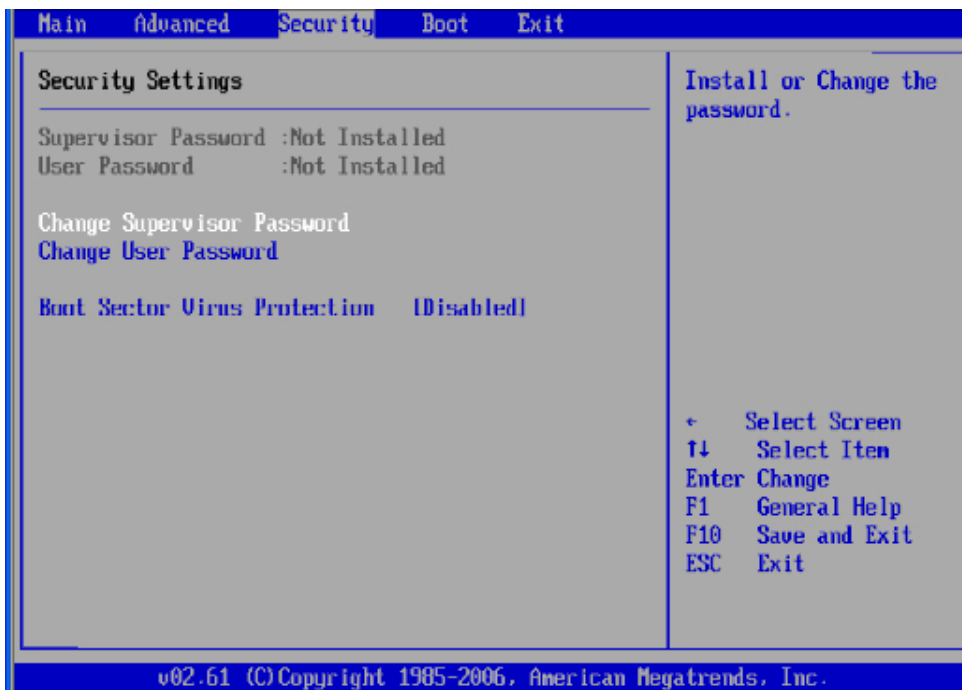


Figure 7-3 Security Settings Screen

This feature indicates if a supervisor's password has been entered (installed).

User Password

This feature indicates if a user's password has been entered (installed).

Change Supervisor Password

Select this option and press <Enter> to access the submenu, and then enter the password.

Change User Password

Select this option and press <Enter> to access the submenu, and then enter the password.

Clear User Password

Note: Available only if User Password has been set.

This item allows you to clear a user password after it has been entered.

Password Check

This item allows you to check a password after it has been entered. The options are **Setup** and **Always**.

Boot Sector Virus Protection

When Enabled, the AMI BIOS displays a warning when any program (or virus) issues a Disk Format command or attempts to write to the boot sector of the hard disk drive. The options are Enabled and **Disabled**.

Boot Configuration

Use this feature to configure boot settings (see [Figure 7-4](#)).

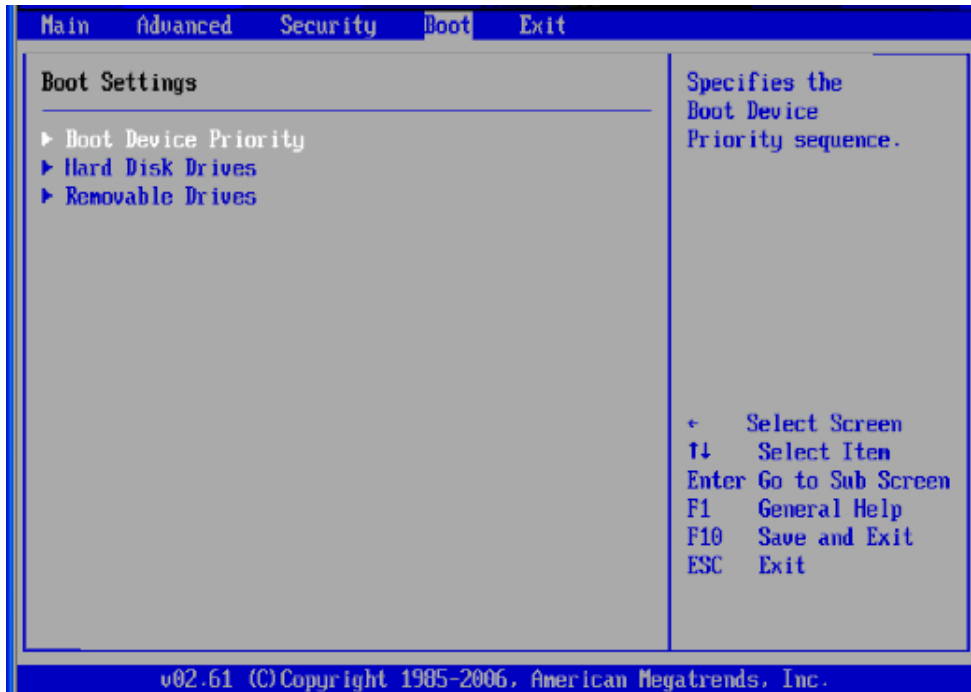


Figure 7-4 Boot Settings Screen

Boot Device Priority

This feature allows the user to specify the sequence of priority for the Boot Device. The settings are 1st boot device, 2nd boot device, 3rd boot device, 4th boot device, 5th boot device and Disabled.

- 1st Boot Device - [USB: XXXXXXXXXX]
- 2nd Boot Device - [CD/DVD: XXXXXXXXXX]

Hard Disk Drives

This feature allows the user to specify the boot sequence from all available hard disk drives. The settings are Disabled and a list of all hard disk drives that have been detected (for example, 1st Drive, 2nd Drive, 3rd Drive, etc).

- 1st Drive - [SATA: XXXXXXXXXXXX]

Removable Drives

This feature allows the user to specify the boot sequence from available Removable Drives. The settings are 1st boot device, 2nd boot device, and Disabled.

- 1st Drive - [USB: XXXXXXXXXXXX]
- 2nd Drive

Exit Options

Select the Exit tab from the AMI BIOS Setup Utility screen to enter the Exit BIOS Setup screen. See [Figure 7-5](#).

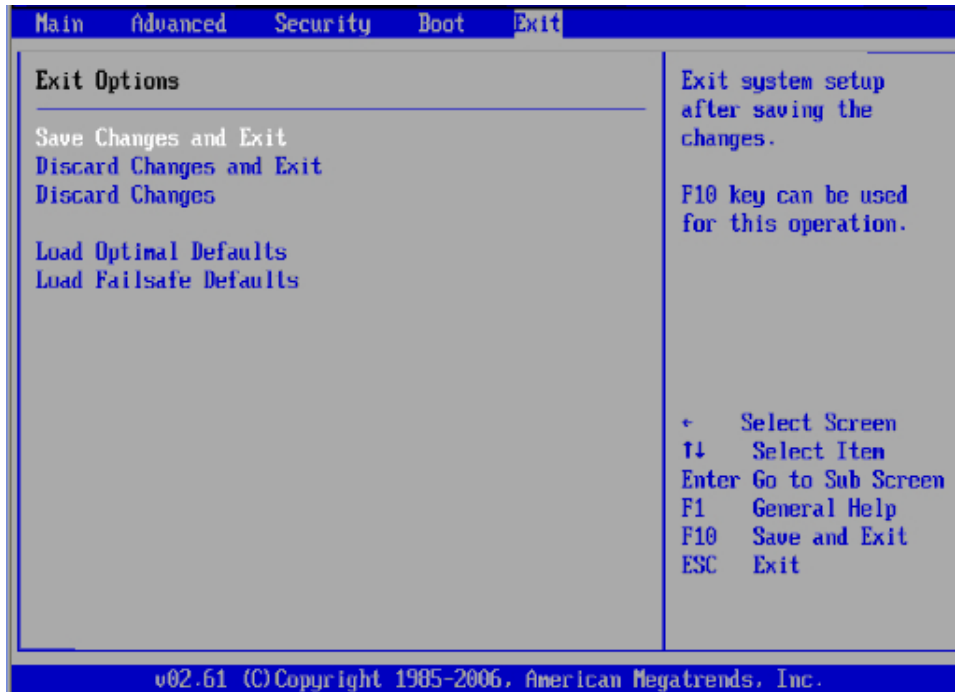


Figure 7-5 Exit Options Screen

Save Changes and Exit

When you have completed the system configuration changes, select this option to leave the BIOS Setup Utility and reboot the computer, so the new system configuration parameters can take effect. Select Save Changes and Exit from the Exit menu and press <Enter>.

Discard Changes and Exit

Select this option to quit the BIOS Setup without making any permanent changes to the system configuration, and reboot the computer. Select Discard Changes and Exit from the Exit menu and press <Enter>.

Discard Changes

Select this option and press <Enter> to discard all the changes and return to the AMI BIOS Utility Program.

Load Optimal Defaults

To set this feature, select Load Optimal Defaults from the Exit menu and press <Enter>. Then, select OK to allow the AMI BIOS to automatically load Optimal Defaults to the BIOS Settings. The Optimal settings are designed for maximum system performance, but may not work best for all computer applications.

Load Fail-Safe Defaults

To set this feature, select Load Fail-Safe Defaults from the Exit menu and press <Enter>. The Fail-Safe settings are designed for maximum system stability, but not for maximum performance.

BIOS Error Codes

During Power-On Self-Test (POST) routines, which are performed each time the system is powered on, errors may occur.

Non-fatal errors are those which, in most cases, allow the system to continue the boot-up process. The error messages normally appear on the screen.

Fatal errors are those which will not allow the system to continue the boot-up procedure. If a fatal error occurs, you should consult with your system manufacturer for possible repairs.

These fatal errors are usually communicated through a series of audible beeps. The numbers on the fatal error list correspond to the number of beeps for the corresponding error.

Table A-1 BIOS Error Codes

Beep Code	Error Message	Description
1 beep	Refresh	Circuits have been reset. Ready to power up.
5 short beeps + 1 long beep	Memory error	No memory detected in the system
8 beeps	Display memory read/write error	Video adapter missing or with faulty memory
1 continuous beep with the front panel OH LED on	System Overheat	Probable problem with system fans/system airflow

System Specifications

Processors

Single or dual Intel Xeon 5500 processors (both CPUs must be of the same type)

Chipset

Intel 5520/ICH10R chipset

BIOS

32 Mb AMI® SPI Flash ROM

Memory Capacity

Eighteen DIMM sockets supporting up to 144 GB of DDR3-1333/1066/800 registered ECC SDRAM

Note: Interleaved memory - requires memory must be installed four modules at a time.

SATA Controller

Intel on-chip (ICH10R) controller for 6-port 3 Gb/s SATA (RAID 0, 1, 10 and 5 supported)

SATA Drive Bays

Eight hot-swap drive bays to house six standard SATA drives

Peripheral Drive Bays

One slim DVD-ROM drive

Expansion Slots

Two PCI-Express Gen. 2 x8 slots (one in a x16 slot), one PCI-Express x4 slot (in a x8 slot), three 64-bit 133/100 MHz PCI-X slots and one UIO slot.

Serverboard

X8DTN+ (Extended ATX form factor)

Dimensions: 13.68 x 13.05 in (348 x 332 mm)

Chassis

SC825TQ-R720LPB (2U rackmount)

Dimensions: (WxHxD) 16.8 x 3.5 x 25.5 in. (427 x 89 x 648 mm)

Weight

Gross (Bare Bone): 57 lbs. (25.9 kg.)

System Cooling

Three (3) 8-cm system cooling fans

System Input Requirements

AC Input Voltage: 100-240V AC auto-range

Rated Input Current: 9A - 4A

Rated Input Frequency: 50 to 60 Hz

Efficiency: 80+ (Gold Level)

Power Supply

Rated Output Power: 720W (Part# PWS-721P-1R)

Rated Output Voltages: +12V (59A), +5Vsb (4A)

Operating Environment

Operating Temperature: 0° to 35° C (32° to 95° F)

Non-operating Temperature: -40° to 70° C (-40° to 158° F)

Operating Relative Humidity: 20% to 95% (non-condensing)

Non-operating Relative Humidity: 5 to 95% (non-condensing)

Regulatory Compliance

Electromagnetic Emissions: FCC Class A, EN 55022 Class A, EN 61000-3-2/-3-3, CISPR 22 Class A

Electromagnetic Immunity: EN 55024/CISPR 24, (EN 61000-4-2, EN 61000-4-3, EN 61000-4-4, EN 61000-4-5, EN 61000-4-6, EN 61000-4-8, EN 61000-4-11)

Safety: CSA/EN/IEC/UL 60950-1 Compliant, UL or CSA Listed (USA and Canada), CE Marking (Europe)

California Best Management Practices Regulations for Perchlorate Materials: This Perchlorate warning applies only to products containing CR (Manganese Dioxide) Lithium coin cells. “Perchlorate Material-special handling may apply. See www.dtsc.ca.gov/hazardouswaste/perchlorate”